

TLK3114SB10-Gbps XAUI Transceiver

Data Manual

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Contents

Se	ection	Title	Page
1	Descr	ription	. 1–1
	1.1	Features	1–5
	1.2	Ordering Information	1–6
2	Termi	nal Descriptions	2–1
3	Detail	led Description	3–1
	3.1	Serdes Modes	3–1
	3.2	10-Gbps Ethernet Transceiver Modes	
	3.3	Parallel Interface Clocking	
	3.4	Parallel Interface Data	3–1
	3.5	Transmit Data Bus Timing	3–2
	3.6	Transmission Latency	
	3.7	Channel Clock to Serial Transmit Clock Synchronization	3–3
	3.8	Receive Data Bus Timing	3–4
	3.9	Data Reception Latency	
	3.10	Auto Detectable HSTL/SSTL_2 Class 1 I/O	
	3.11	8-b/10-b Encoder	
	3.12	Comma Detect and 8-b/10-b Decoding	
	3.13	Channel Initialization and Synchronization	
		3.13.1 Channel State Descriptions	
	3.14	End-of-Packet Error Detection	
	3.15	Fault Detection and Reporting	
	3.16	Receive Synchronization and Skew Compensation	
		3.16.1 Column State Descriptions	
	3.17	Independent Channel Mode	
	3.18	Inter-Packet Gap Management	
	3.19	Clock Tolerance Compensation (CTC)	
	3.20	Parallel-to-Serial Shift Register	
	3.21	Serial-to-Parallel Shift Register	
	3.22	High-Speed VML Output Driver	
	3.23	Device Configuration	
	3.24	PRBS Generator	
	3.25	MDIO Management Interface	
	3.26	Operating Frequency Range	
	3.27	Power-Down Mode	
	3.28	Loopback Testing	
	3.29	Power-On Reset	
	3.30	Differences From the TLK3104SA Device	. 3–37

4	Electi	rical Specifications	4–1
	4.1	Absolute Maximum Ratings Over Operating Free-Air Temperature Range	4–1
	4.2	Recommended Operating Conditions	4–1
	4.3	Reference Clock Timing Requirements (RFCP/N)	
	4.4	Reference Clock Electrical Characteristics (RFCP/N)	
	4.5	LVTTL Electrical Characteristics	
	4.6	SSTL_2 Class 1 Signals	
	4.7	HSTL Signals	
	4.8	Serial Transmitter/Receiver Characteristics	
	4.9	SSTL_2 Class 1/HSTL Output Switching Characteristics	
	4.10 4.11	SSTL_2 Class 1/HSTL Input Timing Requirements	
	4.11	Package Dissipation Rating	
5		anical Data	
0	Wicon		5–1
		List of Illustrations	
_	gure	Title	Page
	-	em Block Diagram (Chip-to-Chip Implementation)	
1–	2 Syste	em Block Diagram (PCS Implementation)	1–2
1–	3 Syste	em Block Diagram (Backplane Interconnect Implementation)	1–2
		3114SB Block Diagram	
1–	5 Block	k Diagram of Individual Channel	1–5
		3114SB GNT/GPV-Package Terminal Diagram	
3–	1 Tran	smit Interface Timing	3–2
3-	2 Tran	smitter Latency	3–3
3–	3 Tran	smit and Reference Clock Relationship (Channel Sync Mode)	3–3
		smit and Reference Clock Relationship	
		ndependent Channel Mode)	3–4
3–	5 Rece	eive Interface Timing	3–4
3–	6 Rece	eiver Latency	3–5
3–	7 Char	nnel Synchronization State Machine	3–7
		of-Packet Error Detection	
3-	9 Rece	eive and Reference Clock Relationship	
	(S	ynchronized Channel Modes)	3–10
3-	10 Col	umn De-skew State Machine	3–11
3–	11 Red	ceive and Reference Clock Relationship	
	(Ir	dependent Channel Modes)	3–12
3–	12 Inte	r-Packet Gap Management	3–13
3–	13 IPG	Management State Machine	3–14

3–14 Channel Synchronization Using Alignment Code	3–15
3–15 Clock Tolerance Compensation: Add	3–16
3–16 Clock Tolerance Compensation: Drop	3–17
3–17 Output Differential Voltage Under Preemphasis	3–18
3–18 Repeater-Mode Block Diagram	
3–19 Management Interface Read Timing	3–20
3–20 Management Interface Write Timing	
3–21 Management Interface Extended Space Address Timing	3–21
3–22 Management Interface Extended Space Write Timing	3–21
3–23 Management Interface Extended Space Read Timing	3–21
3–24 Management Interface Extended Space Read and Increment Timing	
4–1 Differential and Common-Mode Output Voltage Definitions	
4–2 Transmit Template	
4–3 Receive Template	4–4
4–4 Input Jitter	4–4
4–5 SSTL_2 Class 1/HSTL Output Timing Requirements	
4–6 SSTL_2 Class 1/HSTL Data Input Timing Requirements	
4–7 MDIO Read/Write Timing	
4–8 High-Speed I/O Direct-Coupled Mode	4–6
4–9 Example High-Speed I/O AC-Coupled Mode	
4–10 SSTL_2 Class 1 I/O	
4–11 HSTL I/O	
•••••	
List of Tables	
Table Title	Page
2-1 Clock Terminals	2–2
2–2 Serial Side Data Terminals	
2–3 Parallel Data Terminals	2–3
2–4 JTAG Test Port Interface	
2–5 Management Data Interface	
2–7 Voltage Supply and Reference Terminals	
3–1 Operational Interface Modes	
3–2 Parallel Interface Clocking Modes	
3–3 Parallel Data Modes	3–2
3–4 Valid K-Codes	
3–5 Valid XGMII Channel Encodings	
3–6 Receive Data Controls	
3–7 Local and Remote Fault Sequences	3-9

3-8 I	PG Management State Machine Notation	3–14
3-9 F	Programmable Preemphasis	3–18
3–10	Device Configuration	3–19
3–11	MDIO Device Address	3-20
	MDIO Registers	
3–13	Control Register Bit Definitions (Register 0)	3-23
	Status Register Bit Definitions (Register 1)	
3–15	PHY Identifier Bit Definitions (Register 2)	3–24
	PHY Identifier Bit Definitions (Register 3)	
3–17	Extended Status Register Bit Definitions (Register 15)	3-24
3–18	Global Configuration Register Bit Definitions (Register 16)	3–25
3–19	Channel A Configuration Registers Bit Definitions (Register 17)	3-26
3–20	Channel B Configuration Registers Bit Definitions (Register 18)	3–27
	Channel C Configuration Registers Bit Definitions (Register 19)	
3–22	Channel D Configuration Registers Bit Definitions (Register 20)	3–29
	Channel Status Register (Register 22)	
3–24	Channel Synchronization Status Register (Register 23)	3–31
3–25	Clock Tolerance Compensation Status (Register 24)	3–32
3–26	Error Counter Control Register (Register 25)	3-33
3–27	Channel A Error Count (Register 26)	3–33
3–28	Channel B Error Count (Register 27)	3–33
3–29	Channel C Error Count (Register 28)	3–33
	Channel D Error Count (Register 29)	
3–31	PHY XS Control 1 Register (Register 40)	3-33
3–32	PHY XS Status 1 Register (Register 41)	3-34
3–33	PHY XS Speed Ability Register (Register 44)	3-34
3-34	Devices in Package Register (Register 45)	3-34
	10G PHY XS Status 2 Register (Register 48)	
3–36	10G PHY XGXS Lane Status Register (Register 424)	3-34
3-37	PHY XS Register Cross Reference (Registers 432768–432776)	3-35
3–38	DTE XS Control 1 Register (Register 50)	3-35
	DTE XS Status 1 Register (Register 51)	
3-40	DTE XS Speed Ability Register (Register 54)	3-35
3–41	Devices in Package Register (Register 55)	3-35
3-42	10G DTE XS Status 2 Register (Register 58)	3-36
3-43	10G DTE XGXS Lane Status Register (Register 524)	3-36
3-44	DTE XS Register Cross Reference (Registers 532768–532776)	3-36
3-45	Comparison of TLK3104SA and TLK3114SB Devices	3-37

1 Description

The TLK3114SB device is a flexible quad serial transceiver, delivering high-speed, bidirectional, point-to-point data transmissions to provide up to 10 Gbps of data transmission capacity. The TLK3114SB device is terminal compatible with the TLK3104SA quad serial transceiver and supports an operating range of serial data rates from 2.5 Gbps to 3.125 Gbps. The primary application of this device is to provide building blocks for developing point-to-point baseband data transmission over controlled-impedance media of approximately 50 Ω . The transmission media can be printed-circuit board (PCB) traces, copper cables, or fiber-optical media. The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media and the noise coupling into the lines.

The TLK3114SB device performs the parallel-to-serial, serial-to-parallel conversion, and clock extraction functions for a physical layer interface. The TLK3114SB device also provides a selectable 8-b/10-b encode/decode function. The serial transmitter is implemented using differential pseudoemitter controlled logic (PECL) compatible signaling called voltage mode logic (VML) that eliminates the need for external components. The serial receiver employs an equalization circuit to maximize receive capabilities.

The four transceivers in the TLK3114SB device can be configured as either four separate links or synchronized together as a single data path. The TLK3114SB device supports both the 32-bit data path, 4-bit control, 10-gigabit media independent interface (XGMII), and the extended auxiliary unit interface (XAUI) specified in the IEEE 802.3ae 10-Gigabit Ethernet standard. Figure 1–1 shows an example system block diagram for the TLK3114SB device used as an XGMII extended sublayer (XGXS) device to provide an additional trace distance on PCB for data being transferred between the switching fabric and optical transceiver modules.

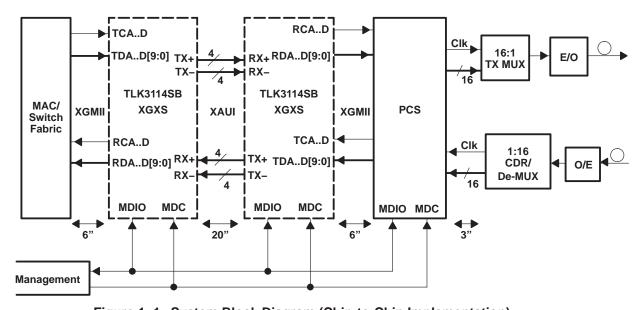


Figure 1–1. System Block Diagram (Chip-to-Chip Implementation)

Figure 1–2 shows an example system block diagram for TLK3114SB device used to provide the 10-Gbps Ehernet physical coding sublayer (as defined in IEEE802.3ae Clause 48) to coarse wavelength division multiplexed optical transceiver.

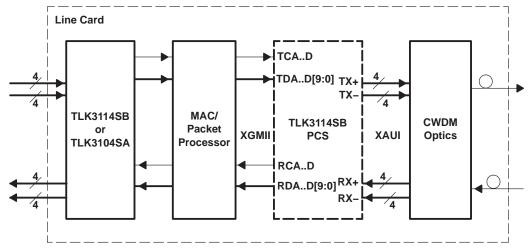


Figure 1–2. System Block Diagram (PCS Implementation)

Figure 1–3 shows an example system block diagram for the TLK3114SB device used to provide the system backplane interconnect.

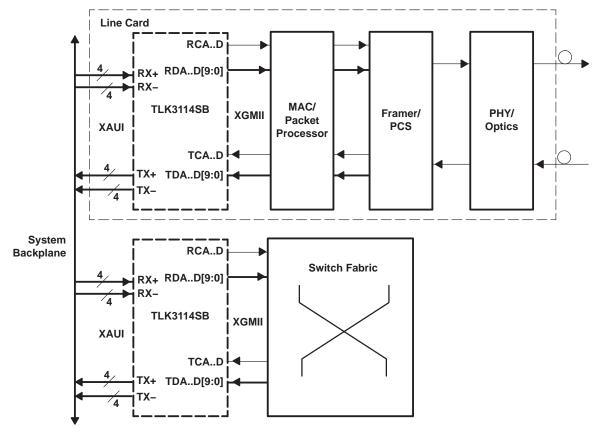


Figure 1-3. System Block Diagram (Backplane Interconnect Implementation)

The TLK3114SB device supports the IEEE 802.3 defined management data input/output (MDIO) interface to allow ease in configuration and status monitoring of the link.

The TLK3114SB device supports the IEEE 1149.1 defined JTAG test port for ease in board manufacturing test. It also supports a comprehensive series of built-in tests for self-test purposes including internal serial loopback and pseudorandom bit stream (PRBS) generation and verification.

The TLK3114SB device operates with a single 2.5-V supply and dissipates less than 3 W. The device is packaged in a 19-mm ×19-mm, 289-terminal plastic ball grid array (PBGA) package and is characterized for operation from 0°C to 70°C.

The TLK3114SB device is a member of a family of CMOS multi-gigabit transceivers, intended for use in high-speed bidirectional point-to-point data transmission systems.

Figure 1–4 provides a high-level description of the TLK3114SB device. For a detailed diagram of the individual channels, see Figure 1–5.

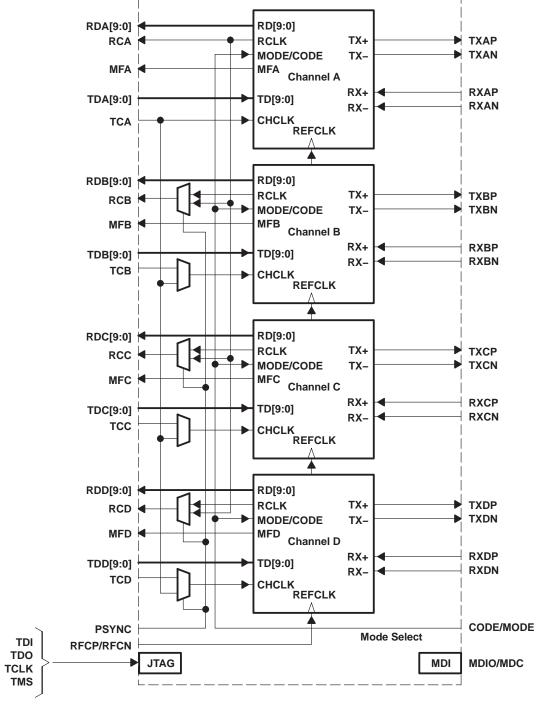


Figure 1-4. TLK3114SB Block Diagram

Figure 1–5 is a more detailed block diagram description of each channel core.

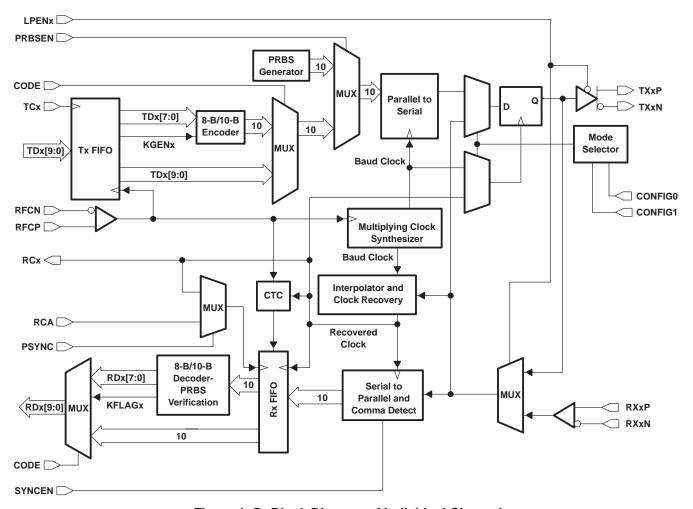


Figure 1-5. Block Diagram of Individual Channel

1.1 Features

- Quad 3.125 Gbps per channel transceiver providing 10-Gbps data throughput
- IEEE 802.3 10-Gbps Ethernet XGXS compliant including:
 - XGMII parallel interface to MAC and XAUI serial interfaces
 - Clock tolerance compensation with column add/drop
 - XAUI interpacket gap /A/, /K/, and /R/ code generation and stripping
 - Remote and local fault reporting on the XGMII as defined
- MDIO interface
- Selectable synchronized or independent channel operation
- Selectable transmit-only, receiver-only, transceiver, and repeater functions
- Selectable on-chip 8-b/10-b ENDEC
- On-chip receive equalization
- Receiver differential input thresholds 200 mV_{P-P}
- On-chip $100-\Omega$ differential receiver termination

- No external filter capacitors required
- VML serial driver providing PECL-compatible differential signaling with no external components
- Auto-selects between HSTL or SSTL_2 Class 1 I/O with on-chip 50-Ω series termination on outputs
- Able to operate with a single 2.5-V power supply
- On-chip PRBS generation and verification controlled from external terminal
- IEEE 1149.1 JTAG test interface
- Hot-plug protection
- Mainstream 250-nm CMOS technology
- $\bullet \quad \text{Small-footprint, 19-mm} \times \text{19-mm, 289-ball PBGA package} \\$

1.2 Ordering Information

Device: TLK3114SBGNT/GPV

GNT and GPV: Plastic ball grid arrays

2 Terminal Descriptions

The TLK3114SB device is available in a 289-terminal MicroStar BGA[™] package (GNT/GPV). The terminal layout for the GNT/GPV package is shown in Figure 2–1. The TLK3114SB pinout is compatible with TLK3104SA board designs.

Pin Out

(Top View) В С D F F G н J ĸ 1 М N Р R т U VDDQ VDDQ 17 **VDDQ GND** RDB3 **VDDQ** GND **RCB VDDQ** GND VREF GND RCC **GND VDDQ** RDC3 GND 17 MFD 16 MFA MFB RDB6 TDB5 TDB8 **VDDQ** TDC5 RDC6 16 VDDQ TDB4 TDC7 TDC4 TDC2 RDC1 VDDQ 15 15 **GND** RDB1 RDB5 RDB8 TDB2 TDB7 TDC9 RDC8 RDC5 **GND** 14 RDA9 RDA8 RDB0 VDDQ GND TDB1 VDDQ GND VDDQ GND VDDQ TDC1 VDDQ RDD8 RDD9 14 RDA6 RDA5 RDB4 RDB7 TDB3 TDB9 TDC6 TDC3 TDC0 RDC7 RDC4 RDD5 RDD6 RDD7 13 RDA7 TDB0 TDB6 13 T-GND T-GND T-GND 12 VDDQ RDA4 RDA3 T-GND T-GND T-GND 12 RDA1 RDA0 VDDQ GND T-GND T-GND T-GND T-GND T-GND T-GND T-GND GND VDDQ RDD0 RDD1 RCD 11 RCA 11 TCA TDA9 TDA8 TDA7 TDA6 T-GND T-GND T-GND T-GND T-GND T-GND T-GND TDD6 TDD7 TDD8 TDD9 TCD 10 10 VDDQ GND TDA5 TDA4 TDA3 T-GND T-GND T-GND T-GND T-GND T-GND T-GND TDD3 TDD4 TDD5 GND VDDQ 9 TDA2 TDA1 TDA0 VDDQ GND T-GND T-GND T-GND T-GND T-GND T-GND T-GND GND VDDQ TDD0 TDD1 TDD2 8 8 VDDA GNDA **GNDA** VDD GND T-GND T-GND T-GND T-GND T-GND T-GND T-GND GND VDD GNDA **GNDA** VDDA 7 VDDA VDDA GND T-GND T-GND T-GND T-GND T-GND T-GND GND TXDN VDDA RXDN VDDA **RXAN** TXAN T-GND 6 6 5 VDDA RXAP VDDA TXAP GND GNDA **GNDA** GND GND GND GNDA **GNDA** GND TXDP VDDA **RXDP** VDDA 5 GNDA GNDA GNDA VDD VDD **TXBP** TXBN VDD VDD VDD TXCN TXCP VDD VDD GNDA GNDA GNDA TCLK LPENA LPENB GNDA VDDA VDDA GND RFCP GND VDDA VDDA GNDA LPENC LPEND PADR2 MDIO 3 TDO TMS CONFIG0 CONFIG1 **GNDA RXBP** RXBN GND RFCN GND **RXCN** RXCP **GNDA** TESTEN PADR4 PADR3 MDC 2 2 ENABLE **RSTN PSYNC** SYNCEN GNDA VDDA VDDA VDD PRBSEN VDD VDDA VDDA GNDA CODE PADR0 PADR1 DADR0 Α

Figure 2–1. TLK3114SB GNT/GPV-Package Terminal Diagram

The terminals are grouped in tables by functionality, such as clocks, serial side data, parallel data, etc. The terminal numbers are also listed for convenient reference.

Table 2-1. Clock Terminals

TERMINAL		XGMII	TVDE	DECORIDATION	
NAME	NUMBER	NAME	NAME	TYPE	DESCRIPTION
RCA A11	A11	RX CLK	CCLK HSTL/SSTL_2 output	Receive data clock, channel A. The data on RDA(0–9) is output on the rising and falling edges of RCA. When PSYNC is high, RCA acts as the receive clock for all channels.	
				This terminal has internal series termination to provide direct connection to a 50- Ω transmission line.	
RCB RCC	F17 M17	N/A	HSTL/SSTL_2	Receive data clock, channels B–D. When PSYNC is low, the data on RDx(0–9) is output on the rising and falling edges of the receive clocks. When PSYNC is high, these terminals are duplicates of RCA.	
RCD U11		output	These terminals have internal series termination to provide direct connection to a 50- Ω transmission line.		
RFCP RFCN	J3 J2	N/A	PECL compatible or LVDS input	Differential reference input clock. This differential pair accepts LVDS- or PECL-compatible signals. When interfacing with 3.3-V PECL, ac-coupling is required. An on-chip $100-\Omega$ termination resistor is placed differentially between the terminals. Internal biasing is provided.	
TCA	A10	TX_CLK	HSTL/SSTL_2 input	Transmit data clock, channel A. The data on TDA(0–9) is latched on the rising and falling edges of TCA. When PSYNC is high, TCA acts as the transmit clock for all channels.	
TCB TCC TCD	F16 M16 U10	N/A	HSTL/SSTL_2 input	Transmit data clock, channels B–D. When PSYNC is low, the data on TDx(0–9) is latched on the rising and falling edges of the transmit clocks. When PSYNC is high, these terminals are undefined.	

Table 2-2. Serial Side Data Terminals

TERMINAL		TVDE	DECODIFICAL	
NAME	NUMBER	TYPE	DESCRIPTION	
RXAP, RXAN RXBP, RXBN RXCP, RXCN RXDP, RXDN	B5, B6 F2, G2 M2, L2 T5, T6	PECL-compatible input	Receive differential pairs, channels A–D. High-speed serial inputs with on-chip $100-\Omega$ differential termination. Each input pair is terminated differentially across an on-chip $100-\Omega$ resistor (see Figure 4–9 and Figure 4–10). These terminals have internal biasing.	
TXAP, TXAN TXBP, TXBN TXCP, TXCN TXDP, TXDN	D5, D6 F4, G4 M4, L4 P5, P6	PECL-compatible output	Transmit differential pairs, channels A–D. High-speed serial outputs.	

Table 2–3. Parallel Data Terminals

TER	MINAL	XGMII		
NAME	NUMBER	NAME	TYPE	DESCRIPTION
RDA[0:7]	C11, B11, E12, D12, C12, C13, B13, A13	RXD[0:7]	HSTL/SST L_2 output	Receive data terminals, channel A. Parallel data on this bus is valid on the rising and falling edges of RCA. These terminals have internal series termination to provide direct connection to a $50-\Omega$ transmission line.
RDA8	B14	RXC0	HSTL/SST L_2 output	Receive data/K-flag, channel A. When CODE is low, this terminal is the ninth bit of a received 8-b/10-b encoded byte. When CODE is high, this terminal acts as the K-character flag. When this terminal is high, it indicates the data on RDA(0–7) is a valid K-character. Data on this terminal is valid on the rising and falling edges of RCA. This terminal has internal series termination to provide direct connection to a 50-Ω transmission line.
RDA9	A14	N/A	HSTL/SST L_2 output	Receive data terminal/error detect, channel A. When CODE is low, this terminal is the tenth bit of a 8-b/10-b encoded byte. When CODE is high, this terminal goes high to signify the occurrence of either a disparity error or an invalid code word during the decoding of the received data. Data on this terminal is valid on the rising and falling edges of RCA. This terminal has internal series termination to provide direct connection to a $50-\Omega$ transmission line.
RDB[0:7]	C14, C15, C16, C17, D13, D15, D16, E13	RXD[8:15]	HSTL/SST L_2 output	Receive data terminals, channels B–D. When PSYNC is low, parallel data on these
RDC[0:7]	R14, R15, R16, R17, P13, P15, P16, N13	RXD[16:23]		buses is valid on the rising and falling edges of the recovered data clock (RCB, RCC, or RCD). When PSYNC is high, data on each bus is valid on the rising and falling edges of RCA. These terminals are series terminated to provide direct connection to a $50-\Omega$
RDD[0:7]	R11, T11, N12, P12, R12, R13, T13, U13	RXD[24:31]		transmission line.
RDB8	E15	RXC1		Receive data/K-flag, channels B–D. When PSYNC is low, data on these terminals is valid on the rising and falling edges of the recovered clock (RCB, RCC, or RCD). When PSYNC is high, data on these terminals is valid on the rising and falling edges of RCA.
RDC8 RDD8	N15 T14	RXC2 RXC3	HSTL/SST L_2 output	When CODE is low, these terminals are the ninth bit of a received 8-b/10-b encoded byte. When CODE is high, these terminals act as the K-character flag. When asserted high, this indicates the data on RDx[0:7] is a valid K-character.
				These terminals are series terminated to provide direct connection to a $50-\Omega$ transmission line.
DDDG	F40	E16 N16 N/A U14	HSTL/SST L_2 output	Receive data terminal/error detect, channels B–D. When PSYNC is low, data on these terminals is valid on the rising and falling edges of recovered channel clock (RCB, RCC, RCD). When PSYNC is high, data on these terminals is valid on the rising and falling edges of RCA.
RDB9 RDC9 RDD9	N16			When CODE is low, these terminals are the tenth bit of a 8-b/10-b encoded byte. When CODE is high, these terminals provide an error detection flag. The error detect is asserted high to signify the occurrence of either a disparity error or an invalid code word during the decoding of the received data.
				These terminals have internal series termination to provide direct connection to a 50- Ω transmission line.

Table 2-3. Parallel Data Terminals (Continued)

TER	RMINAL	XGMII		
NAME	NUMBER	NAME	TYPE	DESCRIPTION
TDA[0:7]	C8, B8, A8, E9, D9, C9, E10, D10	TXD[0:7]	HSTL/SST L_2 input	Transmit data terminals, channel A. Parallel data on this bus is clocked on the rising and falling edges of TCA.
TDA8	C10	TXC0	HSTL/SST L_2 input	Transmit data/KGEN, channel A. When CODE is low, this terminal is the ninth bit of an 8-b/10-b encoded byte to be transmitted. When CODE is high, this terminal acts as the K-character generator indicator. When this terminal is high, it causes the data on TDA(0–7) to be encoded into a K-character.
TDA9	B10	N/A	HSTL/SST L_2 input	Transmit data terminal, channel A. When CODE is low, this terminal is the tenth bit of an 8-b/10-b encoded byte. When CODE is high, this terminal is ignored.
TDB[0:7]	F13, F14, F15, G13, G15, G16, H13, H15	TXD[8:15]		
TDC[0:7]	M13, M14, M15, L13, L15, L16, K13, K15	TXD[16:23]	HSTL/SST L_2 input	Transmit data terminals, channels B–D. When PSYNC is low, parallel data on this bus is clocked on the rising and falling edges of the transmit channel clock (TCB, TCC, TCD). When PSYNC is high, data on these buses is clocked on the rising and falling edges of TCA.
TDD[0:7]	R8, T8, U8, N9, P9, R9, N10, P10	TXD[24:31]		
TDB8 TDC8	H16 K16	TXC1 TXC2	HSTL/SST	Transmit data/KGEN, channels B–D. When PSYNC is low, data on these terminals is clocked on the rising and falling edges of the transmit channel clock (TCB, TCC, or TCD). When PSYNC is high, data on these terminals is clocked on the rising and falling edges of TCA.
TDD8	R10	TXC3	L_2 input	When CODE is low, these terminals are the ninth bit of a 8-b/10-b encoded byte to be transmitted. When CODE is high, these terminals act as the K-character generator indicator. When driven high, these terminals cause the data on TDx(0–7) to be encoded into a K-character.
TDB9 TDC9 TDD9	J13 J15 T10	N/A	HSTL/SST L_2 input	Transmit data terminal, channels B–D. When PSYNC is low, data on this terminal is clocked on the rising and falling edges of the transmit channel clock (TCB, TCC, TCD). When PSYNC is high, data on these terminals are clocked on the rising and falling edges of TCA.
פטטו	110			When CODE is low, these terminals are the tenth bit of an 8-b/10-b encoded byte. When CODE is high, these terminals are ignored.

Table 2-4. JTAG Test Port Interface

TERMINAL			DECODIFIED !	
NAME	NUMBER	TYPE	DESCRIPTION	
TCLK	А3	LVTTL input	JTAG clock. TCLK clocks state information and test data into and out of the device during the operation of the test port.	
TDI	В3	LVTTL input [†]	JTAG input data. TDI serially shifts test data and test instructions into the device during the operation of the test port.	
TDO	A2	LVTTL output	JTAG output data. TDO serially shifts test data and test instructions out of the device during operation of the test port. When the JTAG port is not in use, TDO is in a high-impedance state.	
TMS	B2	LVTTL input [†]	JTAG mode select. TMS controls the state of the internal test-port controller.	

[†] With an internal pullup resistor

Table 2-5. Management Data Interface

TERMINAL		TVDE	DESCRIPTION	
NAME	NUMBER	TYPE	DESCRIPTION	
DADR0	U1	LVTTL input	Management MMD address. DADR0 is the externally set device address, which configures PHY XS or DTE XS according to Table 3–11.	
MDC	U2	LVTTL input	Management data clock. MDC is the clock reference for the transfer of management data to and from the protocol device.	
MDIO	U3	LVTTL I/O	Management data I/O. MDIO is the bidirectional serial data path for the transfer of management data to and from the protocol device.	
PADR(0-4)	R1, T1, T3, T2, R2	LVTTL input	Management PHY address. Device address PADR(0-4) is the externally set physical address given to this device used to distinguish one device from another.	

Table 2-6. Miscellaneous Terminals

TERMINAL				
NAME	NUMBER	TYPE	DESCRIPTION	
CODE	P1	LVTTL input†	Encode enable. When CODE is high, the 8-b/10-b encoder and decoder is enabled.	
CONFIG0 CONFIG1	C2, D2	LVTTL input [‡]	Configuration terminals. These terminals put the device under one of the three operation modes: 00 = Transceiver mode 01 = Transmit-only mode 10 = Receive-only mode 11 = Repeater mode	
ENABLE	A1	LVTTL input†	Standby enable. When this terminal is held low, the device is in a low-power state. When high, the device operates normally.	
LPEN(A-D)	C3, D3, P3, R3	LVTTL input‡	Internal loop enable, channels A–D. When high, the serial output for each channel is internally looped back to its serial input.	
MF(A-D)	A16, B16, T16, U16	LVTTL output	Multifunction outputs, channels A–D. The functions of these terminals are enabled via the MDIO. Currently defined functions are: Terminal indicates 1 for HSTL, 0 for SSTL_2 signaling (default), LOS (loss of signal) for each channel, COMMA_DET (K28.5 character detected) for each channel, and PRBS_STATUS (pseudorandom bit stream test status) for each channel.	
PRBSEN	J1	PRBS enable. When this terminal is asserted high, the PRBS generator and comparator circuit are inserted into the transmit and receive data paths on all channels. PRBS_PASS is indicated of the MFx terminals once they are enabled using MDIO.		
PSYNC	C1	LVTTL input [‡] Channel synchronization enable. When PSYNC is high, all transmit data is latched on the rising and falling edges of TCA and all receive data is valid on the rising and falling edges of RCA.		
RSTN	B1	LVTTL input†	TL input † Chip reset (FIFO clear). Pulling this terminal low recenters the transmit skew buffers, receive channel synchronization FIFOs, and resets MDIO flags.	
SYNCEN	D1	LVTTL input†	Comma detect enable. When this terminal is high, comma detection and byte alignment for all channels are enabled.	
TESTEN	P2	LVTTL input [‡]	Test mode enable. This terminal is used for manufacturing test. This terminal must be left unconnected or tied low.	

[†] With an internal pullup resistor ‡ With an internal pulldown resistor

Table 2–7. Voltage Supply and Reference Terminals

TERMINAL		TVDE	DECORPORTION	
NAME	NUMBER	TYPE	DESCRIPTION	
GND	B9, B12, B15, B17, E5, E6, E7, E8, E11, E14, E17, H2, H3, H5, H14, H17, J5, K2, K3, K5, K14, K17, N5, N6, N7, N8, N11, N14, N17, T9, T12, T15, T17	Ground	Digital logic ground. Supply reference for core logic and SSTL_2 Class 1 buffers.	
GNDA	A4, B4, B7, C4, C7, E1, E2, E3, F5, G5, L5, M5, N1, N2, N3, R4, R7, T4, T7, U4	Ground	Analog ground. Supply reference for analog circuitry.	
T-GND	F6–F12, G6–G12, H6–H12, J6–J12, K6–K12, L6–L12, M6–M12	Ground	Thermal grounds. Electrically connected to GND, these terminals provide a the path for heat dissipation.	
V _{DD}	D4, D7, E4, H1, H4, J4, K1, K4, N4, P4, P7	Supply	Core supply (2.5 V). Digital logic power. Provides power for all digital circuitry.	
V _{DDA}	A5, A6, A7, C5, C6, F1, F3, G1, G3, L1, L3, M1, M3, R5, R6, U5, U6, U7	Supply	Analog voltage supply (2.5 V). Provides power for all analog circuitry.	
V _{DDQ}	A9, A12, A15, A17, D8, D11, D14, D17, G14, G17, J14, J16, L14, L17, P8, P11, P14, P17, U9, U12, U15, U17	Supply	HSTL/SSTL_2 Class 1 supply voltage. Nominally 1.5 V for HSTL or 2.5 V for SSTL_2 Class 1.	
VREF	J17	Input	Input voltage reference for HSTL/SSTL_2 Class 1 I/O	

3 Detailed Description

The TLK3114SB device has four operational interface modes controlled by the states of terminals CODE and PSYNC. These operational interface modes are listed in Table 3–1.

CODE PSYNC DESCRIPTION

Low Low Four independent serializer/deserializers (serdes)

Low High Four synchronized serdes

High Low Four independent transceivers with on-chip 8-b/10-b encode/decode

High High 10-gigabit ethernet XGMII extended sublayer (XGXS) transceiver

Table 3-1. Operational Interface Modes

3.1 Serdes Modes

When CODE is deasserted, the TLK3114SB device performs serialization and deserialization of encoded data across four ten-bit interfaces (TBI) similar to that done in fibre channel and 802.3z gigabit ethernet serdes devices. The channels can be synchronized to allow use of one transmit data clock and one receive data clock.

3.2 10-Gbps Ethernet Transceiver Modes

When CODE and PSYNC are asserted, the TLK3114SB device supports the 32-bit data path, 4-bit control, 10-gigabit media independent interface (XGMII), and full encoding scheme specified in the IEEE 802.3ae 10-Gigabit Ethernet standard. In these modes, the TLK3114SB device performs the serialization/deserialization and channel synchronization function of an extended auxiliary unit interface (XAUI), also specified in the IEEE 802.3ae 10-Gigabit Ethernet standard.

3.3 Parallel Interface Clocking

Two clocking choices are selectable via the PSYNC terminal detailed in Table 3–2. Under channel sync mode (PSYNC is high), TCA is used as the transmit data clock for all four channels. Under independent channel mode (PSYNC is low), each channel uses its own transmit data clock (TCA–TCD) to latch data into the TLK3114SB device. A data FIFO is placed in the transmit data path to resolve any phase difference between the transmit data clocks and differential reference clock, RFCP/N.

Table 3–2. Parallel Interface Clocking Modes

PSYNC	PARALLEL INTERFACE CLOCKING OPERATION		
Low	Independent channel mode. TC[A-D]/RC[A-D] clock in/out each individual channel		
High	Channel sync mode. TCA/RCA clock in/out all channels of data		

On the receive data path, in independent channel mode, the data for each channel is output referenced to each channel's extracted receive clock. In channel sync mode, the data on all channels are synchronized and output referenced to the extracted receive clock for channel A, RCA. A FIFO is enabled in the parallel receive data path on each channel to compensate for channel skew and clock phase tolerance differences between the recovered clocks for each channel and the receive output clock, RCA. This FIFO has a total depth of 11 bytes.

3.4 Parallel Interface Data

Two data mode choices are selectable via the CODE terminal detailed in Table 3–3. In serdes mode, the transmit data bus for each channel accepts 10-bit wide 8-b/10-b encoded data at the TDx[0:9] terminals. Data is latched on the rising and falling edge of the transmit data clock. The 8-b/10-b encoded data is then phase aligned to the reference clock (RFCP/RFCN), serialized, then transmitted sequentially beginning with bit 0 (TDx0) over the differential high-speed serial transmit terminals.

In serdes mode, the receive data bus for each channel outputs 10-bit wide 8-b/10-b encoded data on RDx[0:9]. The 8-b/10-b encoded data input to the differential high-speed serial receive terminals is deserialized with the first bit (bit 0) output on RDx0 and the last bit (bit 9) output on RDx9. Data is output relative to both the rising and falling edges of the receive clock.

Table 3-3. Parallel Data Modes

CODE	PARALLEL INTERFACE DATA OPERATION
Low	Serdes mode. On-chip 8-b/10-b encoder/decoder is disabled. Data on TDx[0:9] and RDx[0:9] is treated as 8-b/10-b encoded data.
High	Transceiver mode. Enables 8-b/10-b encode/decode for each channel. Data TDx[0:7] and RDx[0:7] are treated as uncoded data. TDx8 is used as the K-character generator control. RDx8 is the K-character indicator to the host device. Data on TDx9 is ignored. RDx9 goes high on either a disparity or code error.

In transceiver mode, the transmit data bus for each channel accepts 8-bit wide parallel data at the TDx[0:7] terminals. Data is sampled on the rising and falling edges of the transmit clock as shown in Figure 3–1. The data is first aligned to the reference clock (RFCP/RFCN), then 8-b/10-b encoded and passed to the serializer. The generation of K-characters on each channel is controlled by TDx8 (KGEN). When KGEN is asserted along with the 8 bits of data TDx[0:7], the appropriate 8-b/10-b K-character is transmitted.

In transceiver mode, the receive data bus for each channel outputs an 8-bit wide parallel data on RDx[0:7]. Reception of K-characters is reported on RDx8 (KFLAG). When KFLAG is asserted, the 8 bits of data on RDx[0:7] must be interpreted as a K-character. If an error is uncovered in decoding the data, KFLAG and RDx9 (RX_ER) are asserted and 0xFE is placed on the receive data bus for that channel.

3.5 Transmit Data Bus Timing

For each channel, the transmitter portion of the TLK3114SB device latches the data on transmit data bus TDx[0:9] on both the rising and falling edges of the transmit data clock, as shown in Figure 3–1. Depending on the state of the PSYNC terminal, the transmit data clock is either TCA (channel sync mode) or the individual transmit channel clocks, TCA–TCD (independent channel mode). When in the channel sync mode, signals on TCB, TCC, and TCD are ignored.

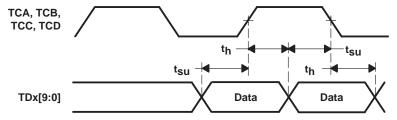


Figure 3-1. Transmit Interface Timing

3.6 Transmission Latency

For each channel, the data transmission latency of the TLK3114SB device is defined as the delay from the rising or falling edge of the selected transmit clock when valid data is on the transmit data terminals to the serial transmission of bit 0, as shown in Figure 3–2. The minimum latency (T_{LATENCY}) is 71 bit times; the maximum is 120 bit times. There are approximately 20 bit times required for the 8-b/10-b encoder.

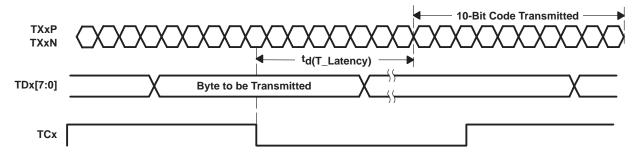


Figure 3-2. Transmitter Latency

3.7 Channel Clock to Serial Transmit Clock Synchronization

The TLK3114SB device requires an external differential reference clock, RFCP/N, for the on-chip phase-locked loop (PLL) and the clock/data recovery loop. To compensate for arbitrary clock phase tolerance differences between the reference clock and the data aligned to the transmit clock, a small FIFO in the parallel transmit data path on each channel is employed. This FIFO has a depth of four bytes.

The reference clock and the transmit data clock(s) are assumed to be from a common source and only phase misaligned due to different path delays as shown in Figure 3–3 and Figure 3–4. The reference clock is multiplied in frequency 10x to produce the internal serialization clock. The internal serialization clock is used to clock out the serial transmit data.

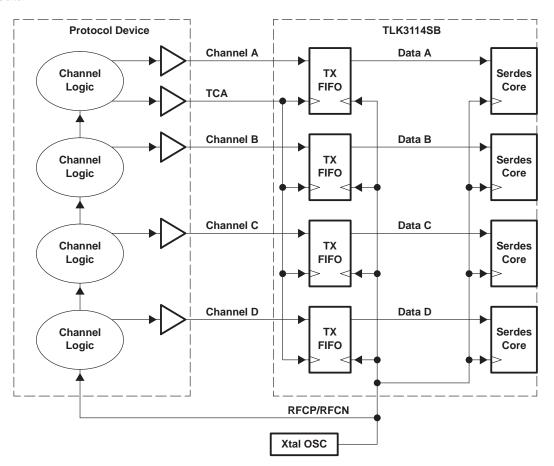


Figure 3-3. Transmit and Reference Clock Relationship (Channel Sync Mode)

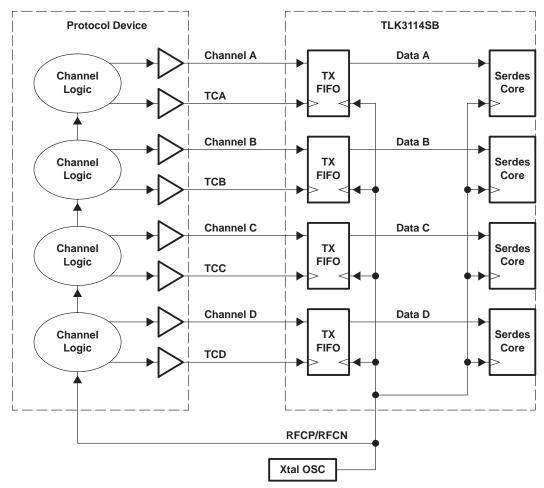


Figure 3-4. Transmit and Reference Clock Relationship (Independent Channel Mode)

3.8 Receive Data Bus Timing

For each channel, the receiver portion of the TLK3114SB device outputs the recovered deserialized data on the receive data bus TDx[0:9] on both the rising and falling edges of the receive data clock, as shown in Figure 3–5. Depending on the state of PSYNC terminal the receive data clock is either RCA (channel sync mode) or the individual receive channel clocks, RCA–RCD (independent channel mode). Terminals RCB, RCC, and RCD are also strobed to match RCA in channel sync mode.

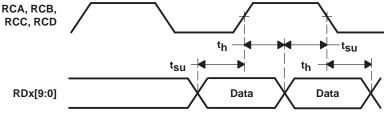


Figure 3-5. Receive Interface Timing

3.9 Data Reception Latency

For each channel, the serial-to-parallel data latency is the time from when the first bit arrives at the receiver input until it is output in the aligned parallel word with RDx0 received as first bit, as shown in Figure 3–6. The minimum latency (R_{LATENCY}) is 84 bit times; the maximum is 225 bit times. The 8-b/10-b encoder, channel de-skew, and CTC all contribute to the maximum latency.

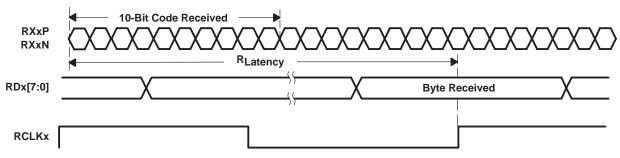


Figure 3-6. Receiver Latency

3.10 Auto Detectable HSTL/SSTL_2 Class 1 I/O

The transmit and receive data buses of the TLK3114SB device are compatible with both high-speed transfer logic (HSTL) supply and stub series terminated logic 2 (SSTL_2) Class 1 buffers. The TLK3114SB device determines which buffer technology to use by sensing the voltage level on the V_{DDQ} supply terminals at power up. If the voltage on the V_{DDQ} supply is between 2.3 V and 2.7 V, the TLK3114SB device provides the necessary drive current to meet SSTL_2 Class 1 requirements. If the voltage on the V_{DDQ} supply is between 1.4 V and 2 V, the TLK3114SB device provides HSTL compatible signaling. During normal operation, the voltage level on the V_{DDQ} terminals must not change.

All HSTL/SSTL_2 Class 1 outputs are series terminated to provide direct connection to a $50-\Omega$ transmission line signaling environment (see Figure 4–10 and Figure 4–11).

3.11 8-b/10-b Encoder

All true serial interfaces require a method of encoding to ensure sufficient transition density for the receiving PLL to acquire and maintain lock. The encoding scheme also maintains the signal dc balance by keeping the number of 1s and 0s the same, which allows for ac-coupled data transmission. The TLK3114SB device uses the 8-b/10-b encoding algorithm that is used by fibre channel and gigabit ethernet. This provides good transition density for clock recovery and improves error checking. The 8-b/10-b encoder/decoder function is enabled for all four channels by the assertion of the CODE terminal. When enabled, the TLK3114SB device internally encodes and decodes the data such that the user reads and writes actual 8-bit data on each channel.

When enabled, the 8-b/10-b encoder converts 8-bit wide data to a 10-bit wide encoded data character to improve its transition density. This transmission code includes D-characters, used for transmitting data, and K-characters, used for transmitting protocol information. Each K- or D-character code word can also have both a positive and a negative disparity version. The disparity of a code word is selected by the encoder to balance the running disparity of the serialized data stream.

The generation of K-characters to be transmitted on each channel is controlled by TDx8 (KGEN). When KGEN is asserted along with the 8 bits of data TDx[0:7], an 8-b/10-b K-character is transmitted. Similarly, reception of K-characters is reported by RDx8 (KFLAG). When KFLAG is asserted, the 8 bits of data on RDx[0:7] must be interpreted as a K-character. The TLK3114SB device transmits and receives all 12 valid K-characters defined in Table 3–4. Table 3–5 provides additional transmit data control coding and descriptions that have been proposed for 10 gigabits per second ethernet. Data patterns put on TDx[0:7], other than those defined in Table 3–4 when TDx8 is asserted, result in an invalid K-character being transmitted, which results in a code error at the receiver.

Table 3-4. Valid K-Codes

		DATA DUO	DATA BUS ENCODED K-CODE		
K-CODE	TDX8 OR RDX8	(RDX[7:0] OR TDX[7:0])	NEGATIVE RUNNING DISPARITY	POSITIVE RUNNING DISPARITY	K-CODE DESCRIPTION
00 through FF	0	ddddddd	ddddddddd	ddddddddd	Normal data
K28.0	1	000 11100	001111 0100	110000 1011	IdleO/busy
K28.1 [†]	1	001 11100	001111 1001	110000 0110	IdleE/busy
K28.2	1	010 11100	001111 0101	110000 1010	
K28.3	1	011 11100	001111 0011	110000 1100	Channel alignment precursor
K28.4	1	100 11100	001111 0010	110000 1101	
K28.5 [†]	1	101 11100	001111 1010	110000 0101	IdleE/not busy
K28.6	1	110 11100	001111 0110	110000 1001	
K28.7 [†]	1	111 11100	001111 1000	110000 0111	Code violation or parity error
K23.7	1	111 10111	111010 1000	000101 0111	IdleO/not busy
K27.7	1	111 11011	110110 1000	001001 0111	SOP(S)
K29.7	1	111 11101	101110 1000	010001 0111	EOP(T)
K30.7	1	111 11110	011110 1000	100001 0111	

[†] A comma is contained within this K-code.

Table 3-5. Valid XGMII Channel Encodings

DATA BUS (TDX[7:0] [†] OR RDX[7:0] [‡])	TDX8§ OR RDX8¶	DESCRIPTION	
00 through FF	0	Normal data transmission	
00 through 06	1	Reserved	
07	1	Idle	
08 through 9B	1	Reserved	
9C	1	Sequence (only valid in channel A)	
9D through FA	1	Reserved	
FB	1	Start (only valid in channel A)	
FC	1	Reserved	
FD	1	Terminate	
FE	1	Transmit error propagation	
FF	1	Reserved	

[†] XGMII names: TDA[7:0] = TXD[7:0], TDB[7:0] = TXD[15:8], TDC[7:0] = TXD[23:16], and TDD[7:0] = TXD[31:24]

3.12 Comma Detect and 8-b/10-b Decoding

When parallel data is clocked into a parallel-to-serial converter, the byte boundary that was associated with the parallel data is lost in the serialization of the data. When the serial data is received and converted to parallel format again, a method is needed to be able to recognize the byte boundary. Generally, this is accomplished through the use of a synchronization pattern. This is a unique pattern of 1s and 0s that either cannot occur as part of valid data or is a pattern that repeats at defined intervals. 8-b/10-b encoding contains a character called the comma (b'0011111' or b'1100000'), which is used by the comma detect circuit to align the received serial data back to its original byte boundary. The decoder detects the K28.5 comma, generating a synchronization signal aligning the data to their 10-bit boundaries for decoding. It then converts the data back into 8-bit data. It is important to note that the comma can be either (b'0011111') or the inverse (b'1100000') depending on the running disparity. The TLK3114SB decoder detects both patterns. Comma detect is not active in PRBS mode.

^{\$\}frac{1}{2}\$ XGMII names: RDA[7:0] = RXD[7:0], RDB[7:0] = RXD[15:8], RDC[7:0] = RXD[23:16], and RDD[7:0] = RXD[31:24]

[§] XGMII names: TDA8 = TXC0, TDB8 = TXC1, TDC8 = TXC2, and TDD8 = TXC3

[¶]XGMII names: RDA8 = RXC0, RDB8 = RXC1, RDC8 = RXC2, and RDD8 = RXC3

The reception of K-characters is reported by the assertion of RDx8 (KFLAG) on each channel. When a code word error or running disparity error is detected in the decoded data on a channel, RDx9 (ERROR DETECT) and KFLAG are asserted and an 0xFE is placed on the receive data bus for that channel, as shown in Table 3–6. When a loss of signal (LOS) is detected on the differential receive inputs, a local fault is reported on the receive data bus (see Section 3.15, Fault Detection and Reporting). The LOS signal can be disabled using MDIO (see Table 3–13).

Table 3-	6 Pa	coivo	Data	Control	-
Table 3-	n Rei	ceive	Data 1	L.Ontrois	5

EVENT	RECEIVE DATA BUS (RDX[7:0])	KFLAG (RDX8)	ERROR DETECT (RDX9)
Normal data	XX	0	0
Normal K-character	Valid K-code (see Table 3-4)	1	0
Loss of signal	See Table 3-7		
Code word error or running disparity error	FE	1	1

3.13 Channel Initialization and Synchronization

The TLK3114SB device has a synchronization state machine, which is responsible for handling link initialization and synchronization for each channel. The initialization and synchronization state diagram is provided in Figure 3–7. The status of any channel can be monitored by reading MDIO registers 4.24 and 5.24, bits 3:0.

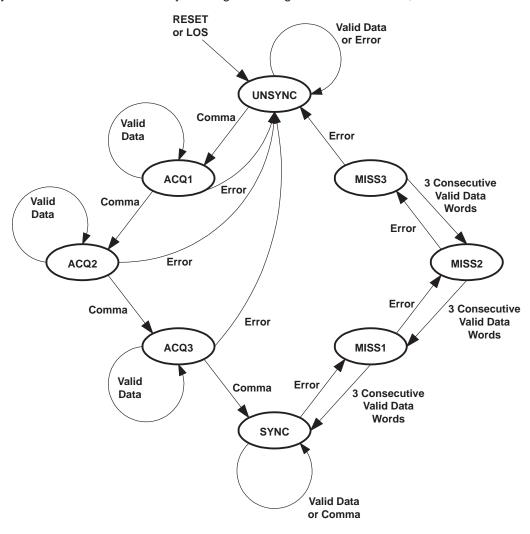


Figure 3-7. Channel Synchronization State Machine

3.13.1 Channel State Descriptions

UNSYNC—This is the initial state for each channel upon device power up or reset. If a LOS condition is detected, the channel state is set to UNSYNC. In this state, the TLK3114SB device has the comma detect circuit active and makes code word alignment adjustments based on the position of a comma in the incoming data stream. While in this state, the TLK3114SB device sets the lane sync bit to 0 for the particular channel in MDIO registers 4.24 and 5.24, bits 3:0, indicating the lane is not synchronized. The channel state transitions to the ACQ1 state upon the detection of a comma.

NOTE: When the lane sync bit equals 0, it causes a local fault to be output on the receive data bus.

ACQ1—During this state the comma detect circuit is active but code word realignment is disabled. The TLK3114SB device remains in this state until either a comma is detected in the same code word alignment position as found in state UNSYNC or a decode error is encountered. While in this state, the lane sync bit for the particular channel remains deasserted indicating the lane is not synchronized. A decode or running disparity error returns the channel state to UNSYNC. A detected comma causes the channel state to transition to ACQ2.

NOTE: When the lane sync bit equals 0, it causes a local fault to be output on the receive data bus.

ACQ2—During this state, the comma detect circuit is active but code word re-alignment is disabled. The TLK3114SB device remains in this state until either a comma is detected in the same code word alignment position as found in state UNSYNC or a decode error is encountered. While in this state, the lane sync bit for the particular channel remains deasserted indicating the lane is not synchronized. A decode or running disparity error returns the channel state to UNSYNC. A detected comma causes the channel state to transition to ACQ3.

NOTE: When the lane sync bit equals 0, it causes a local fault to be output on the receive data bus.

ACQ3—During this state the comma detect circuit is active but code word re-alignment is disabled. The TLK3114SB device remains in this state until either a comma is detected or a decode error encountered. While in this state, the lane sync bit for the particular channel remains deasserted indicating the lane is not synchronized. A decode or running disparity error returns the channel state to UNSYNC. A detected comma causes the channel state to transition to SYNC.

NOTE: When the lane sync bit equals 0, it causes a local fault to be output on the receive data bus.

SYNC—This is the normal state for receiving data. When in this state, the TLK3114SB device sets the lane sync bit to 1 for the particular channel in MDIO registers 4.24 and 5.24, bits 3:0, indicating the lane has been synchronized. During this state the comma detect circuit is active but code word re-alignment is disabled. A decode or running disparity error causes the channel state to transition to MISS1.

MISS1—When entering this state an internal error counter is cleared. If the next three consecutive codes are decoded without error, the channel state reverts back to SYNC. If a decode or running disparity error is detected, the channel state transitions to MISS2.

MISS2—When entering this state an internal error counter is cleared. If the next three consecutive codes are decoded without error, the channel state reverts back to MISS1. If a decode or running disparity error is detected, the channel state transitions to MISS3.

MISS3—When entering this state an internal error counter is cleared. If the next three consecutive codes are decoded without error, the channel state reverts back to MISS1. If a decode or running disparity error is detected, the channel state transitions to UNSYNC.

3.14 End-of-Packet Error Detection

Because of their unique data patterns, /A/ (K28.3), /K/ (K28.5), and /T/ (K29.7) catch running disparity errors that may have propagated undetected from previous codes in a packet. Running disparity errors detected by these control codes at the end of the packets cause the previous data codes to be reported as errors (0xFE) to allow the protocol device to reject the packet (see Figure 3–8).

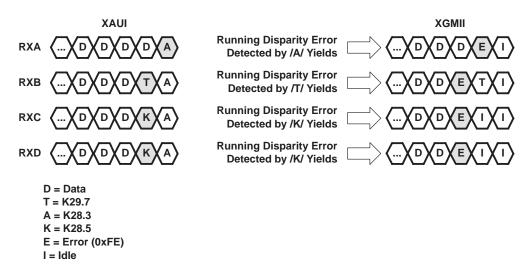


Figure 3-8. End-of-Packet Error Detection

3.15 Fault Detection and Reporting

The TLK3114SB device detects and reports local faults as well as forwards both local and remote faults as defined in the IEEE P802.3ae to aid in fault diagnosis. All faults detected by the TLK3114SB device, such as LOS detect, are reported as local faults to the upper layer protocols, as shown in Table 3–7. Once a local fault is detected in the TLK3114SB device, bit 7 in MDIO registers 4.1 and 5.1 is set. Fault sequences received by the TLK3114SB device, either on the transmit data bus or on the high-speed receiver terminals, are forwarded without change to the MDIO registers in the TLK3114SB device.

The TLK3114SB device reports a fault by outputting a K28.4 (0x9C) on channel A, 0x00 on channels B and C, and either 0x01 for local faults or 0x02 for remote faults on the receive data terminals for channel D. Forwarding of remote faults is handled as a normal transmission.

Table 3-7. Local and Remote Fault Sequences

CHANNEL DESCRIPTION		LOCAL FAULT	REMOTE FAULT
	RDA[7:0]	Sequence [‡]	Sequence [‡]
Channel A†	RDA8	1	1
	RDA9	1	1
	RDB[7:0]	00	00
Channel B	RDB8	0	0
	RDB9	0	0
	RDC[7:0]	00	00
Channel C	RDC8	0	0
	RDC9	0	0
	RDD[7:0]	01	02
Channel D	RDD8	0	0
	RDD9	0	0

[†] Channels A, B, C, and D are equal to the XGMII lanes 0, 1, 2, and 3, respectively.

[‡]The sequence character is equal to 0x9C.

3.16 Receive Synchronization and Skew Compensation

When the TLK3114SB device is configured in channel sync mode, a FIFO is enabled in the parallel receive data path on each channel to compensate for channel skew and clock phase tolerance differences between the recovered clocks for each channel and the receive output clock, RCA, as is shown in Figure 3–9. This FIFO has a depth of 11 bytes.

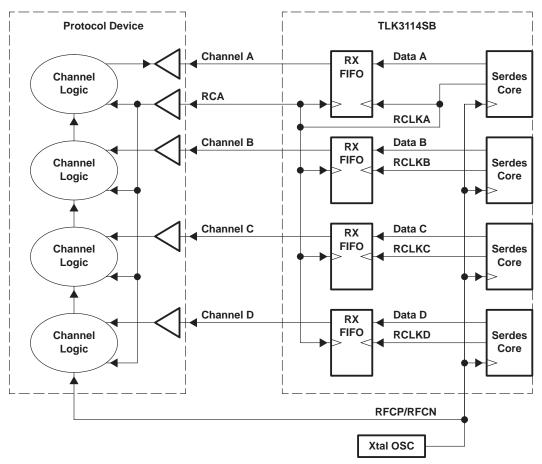


Figure 3-9. Receive and Reference Clock Relationship (Synchronized Channel Modes)

The de-skew of the four channels into a single column of data is accomplished by alignment of the receive FIFOs on each channel to a K28.3 K-character sent during the inter-packet gap (IPG) between data packets or during initial link synchronization. The K28.3 code (referred to as the A or alignment code) is transmitted on the first column following the end of the data packet as shown in Figure 3–12.

The column deskew state machine is provided in Figure 3–10. The status of column alignment can be monitored by reading bit 12 of MDIO registers 4.24 or 5.24 for global alignment, or bits 3:0 of MDIO registers 4.24 or 5.24 for particular channels. Bit 4 of MDIO registers 23, 4.32775, and 5.32775 indicates when a realignment has occurred.

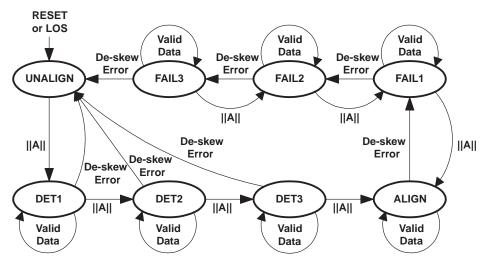


Figure 3-10. Column De-skew State Machine

3.16.1 Column State Descriptions

UNALIGN—This is the initial state for the column state machine upon device power up or reset. If any of the channel state machines are set to UNSYNC, the column state is set to UNALIGN. In this state, the column state machine searches for alignment character codes (K28.3 or /A/) on each channel and aligns the FIFO pointers on each channel to the /A/ character code. While in this state, the column alignment sync bit is set to 0 in MDIO registers 4.24 and 5.24, bit 12, indicating the column is not aligned. The column state transitions to the DET1 state upon the detection and alignment of /A/ character codes in all four channels.

NOTE: When the XGXS lane alignment bit equals 0, it causes a local fault to be output on the receive data bus.

DET1—During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. The column state machine remains in this state looking for a column of alignment character codes. If an incomplete alignment column is detected (alignment character codes not found on all channels), the column state machine transitions to state UNALIGN. While in this state, the column alignment sync bit is set to 0 in MDIO registers 4.24 and 5.24, bit 12, indicating the column is not aligned. Detection of a complete alignment column causes the column state machine to transition to state DET2.

NOTE: When the XGXS lane alignment bit equals 0, it causes a local fault to be output on the receive data bus.

DET2—During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. The column state machine remains in this state looking for a column of alignment character codes. If an incomplete alignment column is detected (alignment character codes not found on all channels), the column state machine transitions to state UNALIGN. While in this state, the column alignment sync bit is set to 0 in MDIO registers 4.24 and 5.24, bit 12, indicating the column is not aligned. Detection of a complete alignment column causes the column state machine to transition to state DET3.

NOTE: When the XGXS lane alignment bit equals 0, it causes a local fault to be output on the receive data bus.

DET3—During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. The column state machine remains in this state looking for a column of alignment character codes. If an incomplete alignment column is detected (alignment character codes not found on all channels), the column state machine transitions to state UNALIGN. While in this state, the column alignment sync bit is set to 0 in MDIO registers 4.24 and 5.24, bit 12, indicating the column is not aligned. Detection of a complete alignment column causes the column state machine to transition to state ALIGN.

NOTE: When the XGXS lane alignment bit equals 0, it causes a local fault to be output on the receive data bus.

ALIGN—This is the normal state for receiving data. When in this state, the column state machine sets the column alignment sync bit to 1 in MDIO registers 4.24 and 5.24, bit 12, indicating all channels are aligned. During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. If a complete alignment column is not detected in the correct position within the IPG, the column state machine transitions to state FAIL1.

FAIL1—When in this state, the column alignment sync bit is 1 in MDIO registers 4.24 and 5.24, bit 12. During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. If a complete alignment column is not detected in the correct position within the IPG, the column state machine transitions to state FAIL2.

FAIL2—When in this state, the column alignment sync bit is 1 in MDIO registers 4.24 and 5.24, bit 12. During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. If a complete alignment column is not detected in the correct position within the IPG, the column state machine transitions to state FAIL3.

FAIL3—When in this state, the column alignment sync bit is 1 in MDIO registers 4.24 and 5.24, bit 12. During this state, the alignment character code detect circuit is active on each channel but the column re-alignment is disabled. If complete alignment column is not detected in the correct position within the IPG, the column state machine transitions to state UNALIGN.

3.17 Independent Channel Mode

When the TLK3114SB device is configured in independent channel mode, the recovered clocks for each channel are used to output the received data on the parallel interface. Thus, as is shown in Figure 3–11, in the independent channel modes, no FIFO is enabled.

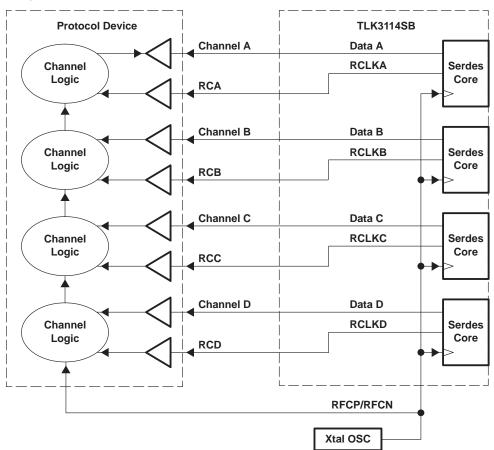


Figure 3-11. Receive and Reference Clock Relationship (Independent Channel Modes)

3.18 Inter-Packet Gap Management

When in the 10-Gbps ethernet XGXS operational mode, the TLK3114SB device replaces the idle codes (see Table 3–5) during the IPG with the necessary codes to perform all channel alignment, byte alignment, and clock tolerance compensation as defined in IEEE 802.3ae, subclause 48.2.4.2. According to clause 46, a valid packet must begin on channel A. However, due to variable packet sizes, the IPG can begin on any channel. The TLK3114SB device replaces idle codes latched on the same TCA (TX_CLK) clock edge as the end of packet code with /K/ codes (as shown in Figure 3–12).

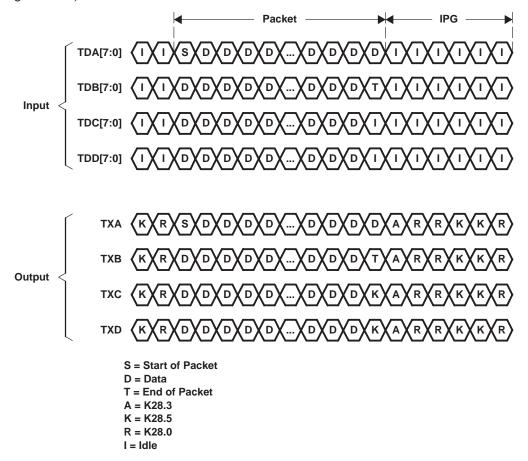


Figure 3-12. Inter-Packet Gap Management

The subsequent idles in the IPG are replaced by columns of channel alignment codes (K28.3), byte alignment codes (K28.5), or clock tolerance compensation codes (K28.0). The state machine, which governs the IPG replacement procedure, is illustrated in Figure 3–13, with notation defined in Table 3–8. Note that any IPG management state transitions to send data if the IPG is terminated.

The repetition of the A pattern on each serial channel allows the FIFOs to remove or add the required phase delay to align the data from all four channels for output on a single edge of the receive clock for channel A, RCA, as shown in Figure 3–14.

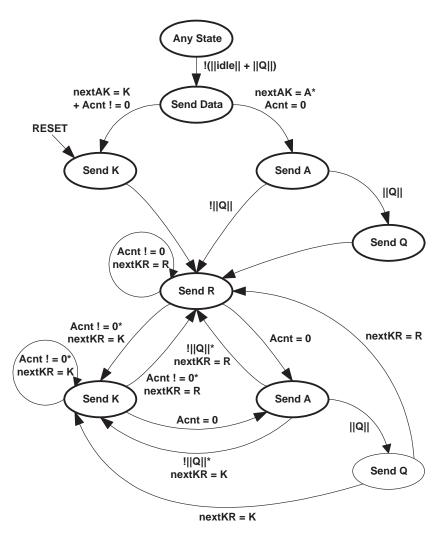


Figure 3-13. IPG Management State Machine

Table 3-8. IPG Management State Machine Notation

SYMBOL	DEFINITION
idle	XGMII idle. 0x07 on TD[A:D].
Q	Link status message: K28.4, Dx.y, Dx.y
nextAK	A Boolean variable. It takes the value K when an A is sent at the beginning of the IPG and the value A when a K is sent at the beginning of the IPG. Its initial value is K.
Acnt	When an A character is sent, variable Acnt is loaded with a random number such that 16 ≤ Acnt ≤ 31. Acnt is decremented each time a column of non-A characters is generated.
nextKR	A randomly-generated Boolean that can assume the value K or R.

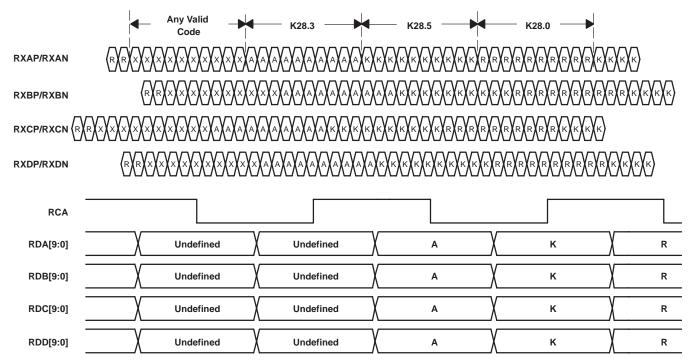


Figure 3-14. Channel Synchronization Using Alignment Code

3.19 Clock Tolerance Compensation (CTC)

The XAUI interface is defined to allow for separate clock domains on each side of the link. Though the reference clocks for two devices on a XAUI link have the same specified frequencies, there are slight differences within those limits that, if not compensated for, lead to over- or underruns of the FIFOs on the receive data path. The TLK3114SB device provides compensation for these differences in reference clock frequencies via the insertion or the removal of R characters on all channels, as shown in Figure 3–15 and Figure 3–16. Bit 11 of MDIO register 16 allows enabling of the CTC, as noted in Table 3–18.

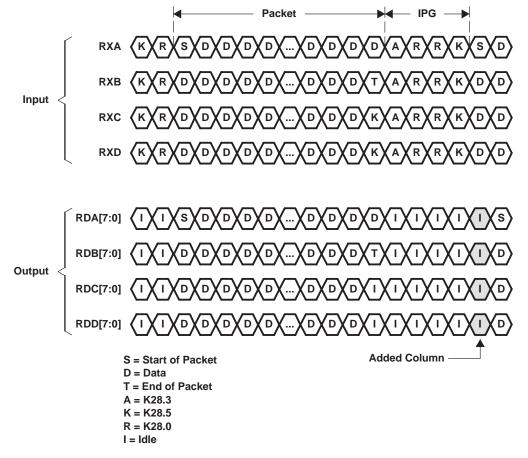


Figure 3-15. Clock Tolerance Compensation: Add

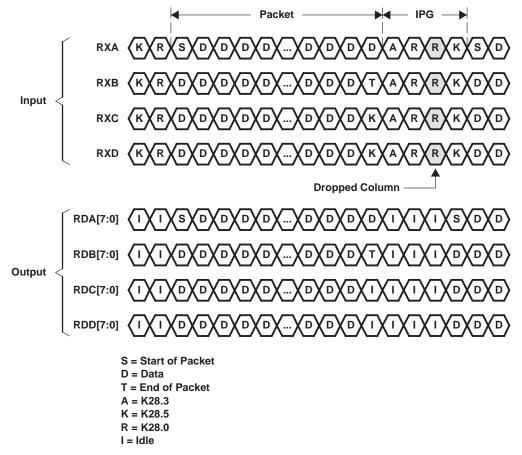


Figure 3-16. Clock Tolerance Compensation: Drop

The R code is disparity neutral, allowing its removal or insertion without affecting the current running disparity of each channel's serial stream.

The clock tolerance compensation circuit also converts XAUI A, K, and R characters to XGMII idles, as illustrated in Figure 3–16.

3.20 Parallel-to-Serial Shift Register

The parallel-to-serial shift register on each channel takes in 10-bit wide data from either the 8-b/10-b encoders, if enabled, or directly from the transmit data bus and converts it to a serial stream. The shift register is clocked by the internally generated bit clock, which is 10 times the reference clock (RFCP/RFCN) frequency. The least significant bit (LSB) for each channel is transmitted first.

3.21 Serial-to-Parallel Shift Register

For each channel, serial data is received on the RXxP/RXxN terminals. The interpolator and clock recovery circuit locks to the data stream if the clock to be recovered is within ±100 PPM of the internally generated bit rate clock. The recovered clock retimes the input data stream. The serial data is then clocked into the serial-to-parallel shift registers. If enabled, the 10-bit wide parallel data is then fed into 8-b/10-b decoders. If the TLK3114SB device is configured in one of the synchronized channel modes, the parallel data for each channel is fed into a FIFO buffer where the output is synchronized to RCA. If the TLK3114SB device is configured in one of the independent channel modes, the parallel data for each channel is output synchronized to each channel's recovered clock.

Transmitting data across PCB or cables attenuates the high frequency content of the signal. This reduces the timing margin for the receiver and clock recovery circuits. The TLK3114SB device applies a filter at the receiver to invert the effects of the interconnect, or equalize and recover some of the lost margin. This maximizes the receiver's ability to recover transmitted data.

3.22 High-Speed VML Output Driver

The high-speed data output driver is implemented using voltage mode logic that offers PECL-compatible differential pair for a $100-\Omega$ differential impedance environment with no external components. The line can be directly coupled or ac coupled. See Figure 4–8 and Figure 4–9 for termination details.

Both current mode logic (CML) and PECL drivers require external components to provide a rising edge (CML) or a falling edge (PECL). The disadvantage of the external edge control is a limited edge rate due to package and line parasitics. In contrast, a VML driver drives and controls both the rising and falling edges inside the package and therefore provides optimum performance for increased speed requirements. Furthermore, the VML driver controls the output voltage swing and adjusts automatically for varying load conditions. The PECL-compatible output provides a nominal 850-mV (singled-ended) swing centered at VDDA/2. The receiver input contains internal biasing for ac-coupling. The receiver internal circuitry sets the common mode voltage to 2xVDDA/3.

When transmitting data across long lengths of PCB trace or cable, the high frequency content of the signal is attenuated due to the skin effect of the media. This causes a smearing of the data eye when viewed on an oscilloscope. The net result is reduced timing margins for the receiver and clock recovery circuits. In order to provide equalization for the high frequency loss, the differential swing is increased or preemphasized for the bit immediately following a transition and subsequently reduced or deemphasized for run lengths greater than one, as shown in Figure 3–17. This provides additional high frequency energy to compensate for PCB or cable loss. The level of the preemphasis is programmable via bits 4 and 5 of MDIO registers 16–20. Users can control the strength of the preemphasis to optimize for a specific system requirement. There are two control bits in the user-defined registers of MDIO to set the preemphasis level, as shown in Table 3–9. See also Table 3–18 for MDIO settings.

PRE1 (Bit 4) REGISTERS 16-20	PRE2 (Bit 5) REGISTERS 16–20	PREEMPHASIS LEVEL $(V_{OD}(p) / V_{OD}(d)-1)^{\dagger}$			
0	0	30%			
1	0	20%			
0	1	10%			
1	1	Preemphasis disabled			

Table 3-9. Programmable Preemphasis

 $^{^{\}dagger}$ V_{OD}(p): Magnitude of the voltage swing when there is a transition in the data stream. V_{OD}(d): Magnitude of the voltage swing when there is no transition in the data stream.

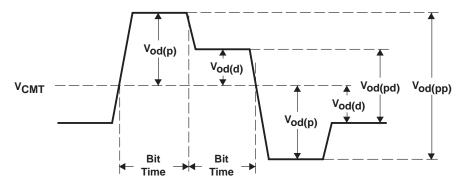


Figure 3-17. Output Differential Voltage Under Preemphasis

3.23 Device Configuration

The TLK3114SB device has four operational configurations controlled by two configuration terminals, CONFIG0 and CONFIG1. These configurations are listed in Table 3–10 and controlled by the MDIO interface (see Table 3–18). When the device is put in a certain mode, unused circuit blocks are powered down to conserve the system power.

Table 3-10. Device Configuration

CONFIG0	CONFIG1	CONFIGURATION
Low	Low	Full-duplex transceiver mode—normal operation (default after reset).
Low	High	Transmit-only mode—data on high-speed data inputs is ignored. Receive data bus is in a high-impedance state.
High	Low	Receive-only mode—high-speed data outputs are in a high-impedance state. Data on the transmit data bus is ignored.
High	High	Repeater mode—recovered serial data and clock are sent back out the transmit serial output.

While transceiver, transmit-only, and receive-only modes are straightforward, the repeater mode of operation is shown in Figure 3–18. The received serial data is recovered by the extracted clock and is then sent back out on the transmit serial output. The data eye opens both vertically and horizontally.

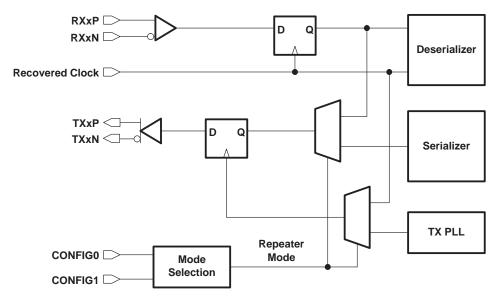


Figure 3-18. Repeater-Mode Block Diagram

3.24 PRBS Generator

The TLK3114SB device has a built-in 2⁷–1 PRBS self-test function available on each channel. The PRBS data pattern represents a worst case data recovery task compared to any 8-b/10-b data pattern combination and is, therefore, a sufficient test for the link and jitter tolerance. The self-test function is enabled by asserting the PRBSEN terminal or setting bit 2 (PRBS enable) of MDIO channel configuration registers 16–20, 4.32768–4.32772, or 5.32768–5.32772. When the self-test function is enabled, PRBS is generated and fed into the 10-bit parallel-to-serial converter input register. Data on the transmit data bus is ignored during the PRBS test mode. The PRBS pattern is then fed through the transmit circuitry as if it were normal data and sent out to the transmitter. The output can be sent to a BERT (bit error rate tester), the receiver of another TLK3114SB channel, or can be looped back to the receive input of the same channel. Since the PRBS is not really random but a predetermined sequence of 1s and 0s, the data can be captured and checked for errors by a BERT.

Result reporting of the PRBS test (PRBS_PASS) is available on each receive channel multifunction (MF[A-D]) terminal. To enable the report of the PRBS tests, see bits 10 and 9 of MDIO register 16, 4.32768, or 5.32768. If SYNCEN is high, then PRBS_PASS latches low on the first occurrence of a bit error. SYNCEN low releases the latch function on PRBS_PASS. MDIO comma detect settings do not affect the latching function.

3.25 MDIO Management Interface

The TLK3114SB device supports the MDIO interface as defined in clauses 22 and 45 of the IEEE 802.3ae Ethernet specification. The MDIO allows register-based management and control of the serial links. Normal operation of the TLK3114SB device is possible without use of this interface since all of the essential signals necessary for operations are accessible via the device terminals. However, some additional features are accessible only through the MDIO.

The MDIO management interface consists of a bidirectional data path (MDIO) and a clock reference (MDC). The timing required to read from the internal registers 0–31 is shown in Figure 3–19. The timing required to write to the internal registers 0–31 is shown in Figure 3–20. The port address is defined by the external inputs PADR(0–4).

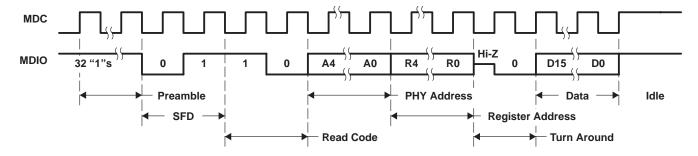


Figure 3-19. Management Interface Read Timing

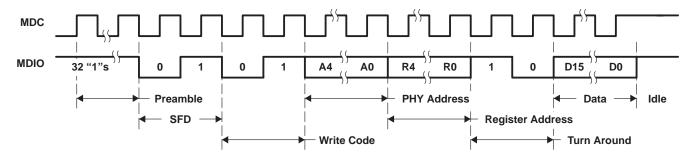


Figure 3-20. Management Interface Write Timing

The extended register address space transactions are orthogonal to register 0–31 transactions, distinguished by the ST bytes. Extended address space registers are denoted X.Y, where X designates the device address and Y designates the register number. The permitted device addresses are shown in Table 3–11. The DADR0 bit is defined by an external input, while the DADR[4:1] bits are predetermined. Write transactions that address an invalid register or device or a read-only register are ignored. Read transactions that address an invalid register return a 0. Read transactions that address an invalid device are ignored.

Timing for an address transaction is shown in Figure 3–21. The timing required to write to the internal registers is shown in Figure 3–22. The timing required to read from the internal registers is shown in Figure 3–23. The timing required to read from the internal registers and then increment the active address for the next transaction is shown in Figure 3–24.

DADR(4:1)	DADR0	DEVICE MODE							
0010	0	PHY XS							
0010	1	DTE XS							

Table 3-11. MDIO Device Address

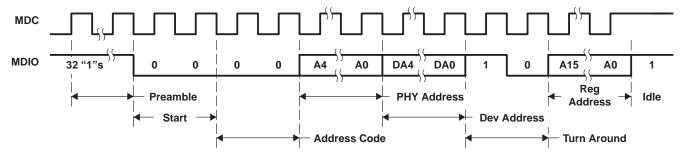


Figure 3-21. Management Interface Extended Space Address Timing

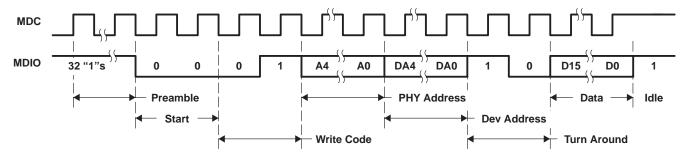


Figure 3-22. Management Interface Extended Space Write Timing

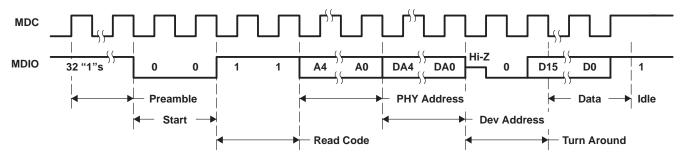


Figure 3-23. Management Interface Extended Space Read Timing

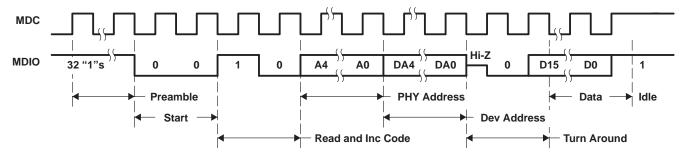


Figure 3-24. Management Interface Extended Space Read and Increment Timing

The IEEE 802.3 Clause 22 and Clause 45 specifications define many of the registers, and additional registers have been implemented for expanded functionality. The IEEE-defined registers and the expanded functionality registers are outlined in Table 3–12.

Table 3-12. MDIO Registers

	T	
REGISTER ADDRESS	REGISTER NAME	DEFINITION
0	Control	IEEE 802.3 defined. See Table 3–13
1	Status	IEEE 802.3 defined. See Table 3–14
2, 3	PHY identifier	IEEE 802.3 defined. See Table 3–15 and Table 3–16
4–14	Not applicable	-
15	Extended status	IEEE 802.3 defined. See Table 3–17
16	Global configuration	See Table 3–18
17–20	Channel A–D configuration	See Table 3–19, Table 3–20, Table 3–21, and Table 3–22
21	Reserved	Reserved
22	Channel status	See Table 3–23
23	Channel sync status	See Table 3–24
24	CTC status	See Table 3–25
25	Error counter control	See Table 3–26
26–29	Channel A-D error count	See Table 3–27, Table 3–28, Table 3–29, and Table 3–30
4.0	PHY XS control 1	IEEE 802.3 defined. See Table 3–31
4.1	PHY XS status 1	IEEE 802.3 defined. See Table 3–32
4.2, 4.3	PHY XS identifier	IEEE 802.3 defined. Same as registers 2, 3
4.4	PHY XS speed ability	IEEE 802.3 defined. See Table 3–33
4.5	Devices in package	IEEE 802.3 defined. See Table 3–34
4.6, 4.7	Not applicable	-
4.8	PHY XS status 2	IEEE 802.3 defined. See Table 3–35
4.9-4.23	Not applicable	-
4.24	10G PHY XGXS lane status	See Table 3–36
4.25-4.32767	Not applicable	-
4.32768	PHY XS global configuration	See Table 3–37
4.32769-4.32772	PHY XS channel A–D configuration	See Table 3–37
4.32773	Reserved	Reserved
4.32774	PHY XS channel status	See Table 3–37
4.32775	PHY XS channel sync status	See Table 3–37
4.32776	PHY XS CTC status	See Table 3–37
4.32777	Error counter control	See Table 3–37
4.32778-4.32781	Channel A-D error count	See Table 3–37
4.32782-4.65535	Not applicable	-
5.0	DTE XS control 1	IEEE 802.3 defined. See Table 3–38
5.1	DTE XS status 1	IEEE 802.3 defined. See Table 3–39
5.2, 5.3	DTE XS identifier	IEEE 802.3 defined. Same as registers 2, 3
5.4	DTE XS speed ability	IEEE 802.3 defined. See Table 3–40
5.5	Devices in package	IEEE 802.3 defined. See Table 3–41
5.6, 5.7	Not applicable	-
5.8	DTE XS status 2	IEEE 802.3 defined. See Table 3-42
5.9–5.23	Not applicable	-
5.24	10G DTE XGXS lane status	See Table 3–43
5.25-5.32767	Not applicable	-
5.32768	DTE XS global configuration	See Table 3–44
5.32769-5.32772	DTE XS channel A–D configuration	See Table 3–44
		<u> </u>

Table 3-12. MDIO Registers (Continued)

REGISTER ADDRESS	REGISTER NAME	DEFINITION
5.32773	Reserved	Reserved
5.32774	DTE XS channel status	See Table 3–44
5.32775	DTE XS channel sync status	See Table 3–44
5.32776	DTE XS CTC status	See Table 3–44
5.32777	Error counter control	See Table 3–44
5.32778-5.32781	Channel A-D error count	See Table 3–44
5.32782-5.65535	Not applicable	-

Several MDIO register bits may be affected by Boolean functions. When a bit value is overridden through a Boolean function, writes to that bit are ignored. The bit returns to its prior value once the override is removed.

Table 3–13. Control Register Bit Definitions (Register 0)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Reset	Logically ORed with the inverse of the RSTN terminal. 1 = Global resets including FIFO clear 0 = Normal operation	Read/Write Self Clearing†
14	Loopback	1 = Enable loopback mode on all channels.0 = Disable loopback mode on all channels (default).	Read/Write
13	Speed selection (LSB)	Not applicable. Read returns a 1.	Read-only
12	Auto-negotiation enable	Not applicable. Read returns a 0.	Read-only
11	Power down	Logically ORed with the inversion of the ENABLE terminal. 1 = Power-down mode is enabled. 0 = Normal operation (default).	Read/Write
10	Isolate	Not applicable. Read returns a 0.	Read-only
9	Restart auto-negotiation	Not applicable. Read returns a 0.	Read-only
8	Duplex mode	Only full duplex is supported. Writes are ignored. Read returns a 1.	Read-only
7	Collision test	Not applicable. Read returns a 0.	Read-only
6	Speed selection (MSB)	Not applicable. Read returns a 1.	Read-only
5:0	Reserved	Write as 0. Ignore on read.	-

[†] After reset, this bit is set to 1; it automatically sets itself back to 0 on the next MDC clock cycle.

Table 3-14. Status Register Bit Definitions (Register 1)

	Table 6 1-11 Status Register Bit Bermittens (Register 1)							
BIT(S)	NAME	DESCRIPTION	READ/WRITE					
15:9		Read returns all 0s.	Read-only					
8	Extended status	Read returns a 1, indicating extended status information is held in register 15.	Read-only					
7	Reserved	Read is ignored.	Read-only					
6:3	Various configurations	Read returns all 0s.	Read-only					
2	Link status	1 = Link is up 0 = Link is down Latches low until read.	Read-only					
1	Jabber detect	Read returns a 0.	Read-only					
0	Extended capability	Read returns a 1, indicating extended register capability.	Read-only					

Registers 2 and 3 contain the identifier for the 10-Gbps ethernet XGXS device.

The identifier code is composed of bits 3–24 of the 25-bit organizationally unique identifier (OUI) assigned to Texas Instruments by the IEEE. The 6-bit manufacturer model number is unique to the TLK3114SB device. The manufacturer revision number denotes the current revision of the TLK3114SB device.

Table 3–15. PHY Identifier Bit Definitions (Register 2)

	OUI ADDRESS BITS 3–18														
2.15	2.14	2.13	2.12	2.11	2.10	2.9	2.8	2.7	2.6	2.5	2.4	2.3	2.2	2.1	2.0
0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Table 3–16. PHY Identifier Bit Definitions (Register 3)

OUI ADDRESS BITS 19-24			MANUFACTURER MODEL NUMBER					MANUFACTURER REVISION NUMBER							
3.15	3.14	3.13	3.12	3.11	3.10	3.9	3.8	3.7	3.6	3.5	3.4	3.3	3.2	3.1	3.0
0	1	0	1	0	0	0	0	0	1	0	1	0	0	0	0

Table 3–17. Extended Status Register Bit Definitions (Register 15)

	BIT(S)	NAME	DESCRIPTION	READ/WRITE	
	15:12	Various configurations	Read returns all 0s.	Read-only	
Γ	11:0	Reserved	Read returns all 0s.	Read-only	

See also registers 17–20 for individual channel configurations.

Writing to register 16 overwrites any previous settings to registers 17–20.

Table 3–18. Global Configuration Register Bit Definitions (Register 16)

BIT(S)	NAME	DESCRIPTION	READ/WRITE	
15	Reserved	Read returns 0, writes are ignored.	Read-only	
14	De-skew state machine	1 = Enable deskew state machine described in Figure 3–10. 0 = Disable deskew state machine (default).	Read/Write	
13	Channel synchronization state machine	1 = Enable channel synchronization state machine described in Figure 3–7. 0 = Disable channel synchronization state machine (default).	Read/Write	
12	IPG management state machine	1 = Enable IPG management state machine described in Figure 3–13. 0 = Disable IPG management state machine (default).	Read/Write	
11	Clock tolerance compensation	1 = Enable clock tolerance compensation.0 = Disable clock tolerance compensation (default).	Read/Write	
10:9	Multifunction pin output	Bit 10 Bit 9 Output 0 0 HSTL = 1, SSTL_2 = 0 (default) 0 1 1 = Comma detected, 0 = data 1 0 Register 22, bits 3–0 (LOS) 1 1 Register 22, bits 7–4 (PRBS pass)	Read/Write	
8	Loss of signal detection	1 = Enable LOS condition described in Table 3–6 for all channels (default). 0 = Disable this function.	Read/Write	
7	Configuration: Config1	Configuration bits (see Table 3–10), default value = 0. When CONFIG1 = low, this bit can be set to 1. When CONFIG1 = high, this bit is read-only. Logically ORed with external input CONFIG1.	Read/Write	
6	Configuration: Config0	Configuration bits (see Table 3–10), default value = 0 When CONFIG0 = low, this bit can be set to 1. When CONFIG0 = high, this bit is read-only. Logically ORed with external input CONFIG0.	Read/Write	
5	Preemphasis: Pre2	Programmable preemphasis control (see Table 3–9), default value = 0.	Read/Write	
4	Preemphasis: Pre1	Programmable preemphasis control (see Table 3–9), default value = 0.	Read/Write	
3	Reserved	Read returns a 0, writes are ignored.	Read-only	
2	PRBS enable	1 = Enable PRBS internal generation and verification on all channels 0 = Normal operation (default). When PRBSEN = low, this bit can be set to 1. When PRBSEN = high, this bit is read-only. Logically ORed with PRBSEN.	Read/Write	
1	Comma detect enable 1 = Enable K28.5 code detection and bit alignment on all channels (default). 0 = Disable K28.5 code detection on all channels. Logically AND'ed with SYNCEN.			
0	Reserved	Read returns a 0, writes are ignored.	Read/Write	

Table 3–19. Channel A Configuration Registers Bit Definitions (Register 17)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:12	Reserved	Read returns all 0s, writes are ignored.	Read-only
11	Clock tolerance compensation	1 = Enable clock tolerance compensation. 0 = Disable clock tolerance compensation (default). Logically ORed with register 16, bit 11.	Read/Write
10:9	Multifunction pin output	Multifunction (MFA) pin configuration for channel A. Bit 10 Bit 9 MFA Output 0 0 HSTL = 1, SSTL_2 = 0 (default) 0 1 1 = Comma detected, 0 = data 1 0 Register 22, bit 0 (LOS) 1 1 Register 22, bit 4 (PRBS pass) Logically ORed with register 16, bits 10 and 9.	Read/Write
8	Loss of Signal Detection	1 = Enable LOS condition described in Table 3–7 for channel A (default). 0 = Disable this function. Logically AND'ed with register 16, bit 8.	Read/Write
7	Configuration: Config1	Configuration bits (see Table 3–10), default value = 0 When CONFIG1 = low, this bit can be set to 1. When CONFIG1 = high, this bit is read-only. Logically ORed with register 16, bit 7.	Read/Write
6	Configuration: Config0	Configuration bits (see Table 3–10), default value = 0 When CONFIG0 = low, this bit can be set to 1. When CONFIG0 = high, this bit is read-only. Logically ORed with register 16, bit 6.	Read/Write
5	Preemphasis: Pre2	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 5.	Read/Write
4	Preemphasis: Pre1	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 4.	Read/Write
3	Loopback	1 = Enable loopback mode on channel A. 0 = Disable loopback mode on channel A (default). Logically ORed with register 0, bit 14. When LPENA = low, this bit can be set to 1. When LPENA = high, this bit is read-only.	Read/Write
2	PRBS enable	1 = Enable PRBS internal generation and verification on channel A 0 = Normal operation (default). Logically ORed with register 16, bit 2. When PRBSEN = low, this bit can be set to 1. When PRBSEN = high, this bit is read-only.	Read/Write
1	Comma detect enable	1 = Enable K28.5 code detection and bit alignment on channel A (default). 0 = Disable K28.5 code detection on channel A. Logically AND'ed with SYNCEN and register 16, bit 1.	Read/Write
0	Power down	1 = Power-down mode is enabled for channel A. 0 = Normal operation (default). Logically ORed with register 0, bit 11.	Read/Write

Table 3–20. Channel B Configuration Registers Bit Definitions (Register 18)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:12	Reserved	Read returns all 0s, writes are ignored.	Read-only
11	Clock tolerance compensation	1 = Enable clock tolerance compensation. 0 = Disable clock tolerance compensation (default). Logically ORed with register 16, bit 11.	Read/Write
10:9	Multifunction pin output	Multifunction (MFB) pin configuration for channel B. Bit 10 Bit 9 MFB Output 0 0 HSTL = 1, SSTL_2 = 0 (default) 0 1 1 = Comma detected, 0 = data 1 0 Register 22, bit 1 (LOS) 1 1 Register 22, bit 5 (PRBS Pass) Logically ORed with register 16, bits 10 and 9.	Read/Write
8	Loss of signal detection	1 = Enable LOS condition described in Table 3–7 for channel B (default). 0 = Disable this function. Logically AND'ed with register 16, bit 8.	Read/Write
7	Configuration: Config1	Configuration bits (see Table 3–10), default value = 0. When CONFIG1 = low, this bit can be set to 1. When CONFIG1 = high, this bit is read-only. Logically ORed with register 16, bit 7.	Read/Write
6	Configuration: Config0	Configuration bits (see Table 3–10), default value = 0 When CONFIG0 = low, this bit can be set to 1. When CONFIG0 = high, this bit is read-only. Logically ORed with register 16, bit 6.	Read/Write
5	Preemphasis: Pre2	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 5.	Read/Write
4	Preemphasis: Pre1	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 4.	Read/Write
3	Loopback	1 = Enable loopback mode on channel B. 0 = Disable loopback mode on channel B (default). Logically ORed with register 0, bit 14.	Read/Write
2	PRBS enable	1 = Enable PRBS internal generation and verification on channel B. 0 = Normal operation (default). Logically ORed with register 16, bit 2. When PRBSEN = low, this bit can be set to 1. When PRBSEN = high, this bit is read-only.	Read/Write
1	Comma detect enable	1 = Enable K28.5 code detection and bit alignment on channel B (default). 0 = Disable K28.5 code detection on channel B. Logically AND'ed with SYNCEN and register 16, bit 1.	Read/Write
0	Power down	1 = Power-down mode is enabled for channel B. 0 = Normal operation (default). Logically ORed with register 0, bit 11.	Read/Write

Table 3–21. Channel C Configuration Registers Bit Definitions (Register 19)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:12	Reserved	Read returns all 0s, writes are ignored.	Read-only
11	Clock tolerance compensation	1 = Enable clock tolerance compensation. 0 = Disable clock tolerance compensation (default). Logically ORed with register 16, bit 11.	Read/Write
10:9	Multifunction pin output	Bit 10 Bit 9 MFC Output 0 0 HSTL = 1, SSTL_2 = 0 (default) 0 1 1 = Comma detected, 0 = data 1 0 Register 22, bit 2 (LOS) 1 1 Register 22, bit 6 (PRBS Pass) Logically ORed with register 16, bits 10 and 9.	Read/Write
8	Loss of signal detection	1 = Enable LOS condition described in Table 3–7 for channel C (default). 0 = Disable this function. Logically AND'ed with register 16, bit 8.	Read/Write
7	Configuration: Config1	Configuration bits (see Table 3–10), default value = 0 When CONFIG1 = low, this bit can be set to 1. When CONFIG1 = high, this bit is read-only. Logically ORed with register 16, bit 7.	Read/Write
6	Configuration: Config0	Configuration bits (see Table 3–10), default value = 0 When CONFIG0 = low, this bit can be set to 1. When CONFIG0 = high, this bit is read-only. Logically ORed with register 16, bit 6.	Read/Write
5	Preemphasis: Pre2	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 5.	Read/Write
4	Preemphasis: Pre1	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 4.	Read/Write
3	Loopback	1 = Enable loopback mode on channel C. 0 = Disable loopback mode on channel C (default). Logically ORed with register 0, bit 14.	Read/Write
2	PRBS enable	1 = Enable PRBS internal generation and verification on channel C. 0 = Normal operation (default). Logically ORed with register 16, bit 2 When PRBSEN = low, this bit can be set to 1. When PRBSEN = high, this bit is read-only.	Read/Write
1	Comma detect enable	1 = Enable K28.5 code detection and bit alignment on channel C (default). 0 = Disable K28.5 code detection on channel C. Logically AND'ed with SYNCEN and register 16, bit 1.	Read/Write
0	Power down	1 = Power-down mode is enabled for channel C. 0 = Normal operation (default). Logically ORed with register 0, bit 11.	Read/Write

Table 3–22. Channel D Configuration Registers Bit Definitions (Register 20)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:12	Reserved	Read returns all 0s, writes are ignored.	Read-only
11	Clock tolerance compensation	1 = Enable clock tolerance compensation. 0 = Disable clock tolerance compensation (default). Logically ORed with register 16, bit 11	Read/Write
10:9	Multifunction pin output	Multifunction (MFD) pin configuration for channel D. Bit 10 Bit 9 MFD Output 0 0 HSTL = 1, SSTL_2 = 0 (default) 0 1 1 = Comma detected, 0 = data 1 0 Register 22, bit 3 (LOS) 1 1 Register 22, bit 7 (PRBS Pass) Logically ORed with register 16, bits 10 and 9.	Read/Write
8	Loss of signal detection	1 = Enable LOS condition described in Table 3–7 for channel D (default). 0 = Disable this function. Logically AND'ed with register 16, bit 8.	Read/Write
7	Configuration: Config1	Configuration bits (see Table 3–10), default value = 0 When CONFIG1 = low, this bit can be set to 1. When CONFIG1 = high, this bit is read-only. Logically ORed with register 16, bit 7.	Read/Write
6	Configuration: Config0	Configuration bits (see Table 3–10), default value = 0 When CONFIG0 = low, this bit can be set to 1. When CONFIG0 = high, this bit is read-only. Logically ORed with register 16, bit 6.	Read/Write
5	Preemphasis: Pre2	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 5.	Read/Write
4	Preemphasis: Pre1	Programmable preemphasis control (see Table 3–9), default value = 0. Logically ORed with register 16, bit 4.	Read/Write
3	Loopback	1 = Enable loopback mode on channel D. 0 = Disable loopback mode on channel D (default). Logically ORed with register 0, bit 14	Read/Write
2	PRBS enable	1 = Enable PRBS internal generation and verification on channel D 0 = Normal operation (default) Logically ORed with register 16, bit 2 When PRBSEN = low, this bit can be set to 1. When PRBSEN = high, this bit is read-only.	Read/Write
1	Comma detect enable	1 = Enable K28.5 code detection and bit alignment on channel D (default). 0 = Disable K28.5 code detection on channel D. Logically AND'ed with SYNCEN and register 16, bit 1	Read/Write
0	Power down	1 = Power-down mode is enabled for channel D. 0 = Normal operation (default) Logically ORed with register 0, bit 11	Read/Write

Table 3-23. Channel Status Register (Register 22)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Channel D transmit FIFO collision error	1 = Collision error is detected to cause the transmit FIFO self reset. 0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	
14	14 Channel C transmit FIFO collision error	1 = Collision error is detected to cause the transmit FIFO self reset. 0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	
13	Channel B transmit FIFO collision error	1 = Collision error is detected to cause the transmit FIFO self reset. 0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	
12	Channel A transmit FIFO collision error	1 = Collision error is detected to cause the transmit FIFO self reset. 0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	
		1 = Code word or running disparity error detected.	
11	Channel D decode error	0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	+
10	Channel C decede arror	1 = Code word or running disparity error detected. 0 = No error (default)	Dood only
10	Channel C decode error	After being read, this bit is reset to 0.	Read-only
		1 = Code word or running disparity error detected.	+
9	Channel B decode error	0 = No error (default)	Read-only
Ü	Charmon B access on or	After being read, this bit is reset to 0.	Trodd orny
		1 = Code word or running disparity error detected.	+
8	Channel A decode error	0 = No error (default)	Read-only
		After being read, this bit is reset to 0.	
		1 = PRBS testing passes without error (default).	Read-only
7	Channel D PRBS pass	0 = Error is detected during PRBS test.	
		After PRBS_PASS has been cleared, reading this bit sets it to 1.	
		1 = PRBS testing passes without error (default).	
6	Channel C PRBS pass	0 = Error is detected during PRBS test.	Read-only
		After PRBS_PASS has been cleared, reading this bit sets it to 1.	-
5	Channel B PRBS pass	1 = PRBS testing passes without error (default). 0 = Error is detected during PRBS test.	Read-only
5	Chamille D 1 1100 pass	After PRBS_PASS has been cleared, reading this bit sets it to 1.	Troad-only
		1 = PRBS testing passes without error (default).	+
4	Channel A PRBS pass	0 = Error is detected during PRBS test	Read-only
	· ·	After PRBS_PASS has been cleared, reading this bit sets it to 1.	ĺ
		1 = LOS condition is reported.	1
3	Channel D LOS output	0 = No LOS (default)	Read-only
		After being read, this bit is reset to 0.	
		1 = LOS condition is reported.	
2	Channel C LOS output	0 = No LOS (default)	Read-only
		After being read, this bit is reset to 0.	-
1	Channel B I OC autout	1 = LOS condition is reported. 0 = No LOS (default)	Decid 1
	Channel B LOS output	After being read, this bit is reset to 0.	Read-only
			+
0		1 = LOS condition is reported.	
0	Channel A LOS output	0 = No LOS (default)	Read-only

Table 3–24. Channel Synchronization Status Register (Register 23)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:5	Reserved	Read returns all 0s.	Read-only
4	Channel align flag	1 = Channel deskew circuit has realigned to a K28.3 /A/ code word on all channels. 0 = No /A/ has been detected.	Read-only
		After being read, this bit is reset to 0.	
3	Channel D receive FIFO collision error	1 = Collision error is detected to cause the receive FIFO self reset. 0 = No error.	Read-only
		After being read, this bit is reset to 0.	
2	Channel C receive FIFO collision error	1 = Collision error is detected to cause the receive FIFO self reset. 0 = No error.	Read-only
		After being read, this bit is reset to 0.	
1	Channel B receive FIFO collision error	1 = Collision error is detected to cause the receive FIFO self reset. 0 = No error.	Read-only
	collision error	After being read, this bit is reset to 0.	
0	Channel A receive FIFO collision error	1 = Collision error is detected to cause the receive FIFO self reset. 0 = No error.	Read-only
		After being read, this bit is reset to 0.	

Table 3-25. Clock Tolerance Compensation Status (Register 24)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Channel D drop idle column	1 = IDLE column has been dropped. 0 = No IDLE column dropped. After being read, this bit is reset to 0.	Read-only
14	Channel C drop idle column	1 = IDLE column has been dropped. 0 = No IDLE column dropped. After being read, this bit is reset to 0.	Read-only
13	Channel B drop idle column	1 = IDLE column has been dropped. 0 = No IDLE column dropped. After being read, this bit is reset to 0.	Read-only
12	Channel A drop idle column	1 = IDLE column has been dropped. 0 = No IDLE column dropped. After being read, this bit is reset to 0.	Read-only
11	Channel D insert idle column	1 = IDLE column has been inserted. 0 = No IDLE column inserted. After being read, this bit is reset to 0.	Read-only
10	Channel C insert idle column	1 = IDLE column has been inserted. 0 = No IDLE column inserted. After being read, this bit is reset to 0.	Read-only
9	Channel B insert idle column	1 = IDLE column has been inserted. 0 = No IDLE column inserted. After being read, this bit is reset to 0.	Read-only
8	Channel A insert idle column	1 = IDLE column has been inserted. 0 = No IDLE column inserted. After being read, this bit is reset to 0.	Read-only
7	Channel D FIFO overflow	1 = FIFO overflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
6	Channel C FIFO overflow	1 = FIFO overflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
5	Channel B FIFO overflow	1 = FIFO overflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
4	Channel A FIFO overflow	1 = FIFO overflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
3	Channel D FIFO underflow	1 = FIFO underflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
2	Channel C FIFO underflow	1 = FIFO underflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
1	Channel B FIFO underflow	1 = FIFO underflow condition 0 = No error After being read, this bit is reset to 0.	Read-only
0	Channel A FIFO underflow	1 = FIFO underflow condition 0 = No error After being read, this bit is reset to 0.	Read-only

Table 3-26. Error Counter Control Register (Register 25)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:5	Reserved	Read returns all 0s.	Read-only
4	Rx PSYNC	0 = RC(A–D) clocks out individual channel. Transmit clocking is unaffected. 1 = All receive data is valid on the rising and falling edges of RCA (default). Logically AND'ed with PSYNC terminal.	Read/Write
3	Channel D counter select	0 = Running disparity error counter (default). 1 = Decode error counter	Read/Write
2	Channel C counter select	0 = Running disparity error counter (default). 1 = Decode error counter	Read/Write
1	Channel B counter select	0 = Running disparity error counter (default). 1 = Decode error counter	Read/Write
0	Channel A counter select	0 = Running disparity error counter (default). 1 = Decode error counter	Read/Write

Table 3-27. Channel A Error Count (Register 26)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:0	Error count	Channel A running disparity or decode error count value selected by register 25, bit 0. After being read, this counter is reset to 0.	Read-only

Table 3-28. Channel B Error Count (Register 27)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:0	Error count	Channel B running disparity or decode error count value selected by register 25, bit 1.	Read-only
		After being read, this counter is reset to 0.	

Table 3-29. Channel C Error Count (Register 28)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:0	Error count	Channel C running disparity or decode error count value selected by register 25, bit 2.	Read-only
		After being read, this counter is reset to 0.	

Table 3-30. Channel D Error Count (Register 29)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:0	Error count	Channel D running disparity or decode error count value selected by register 25, bit 3.	Read-only
		After being read, this counter is reset to 0.	

Table 3-31. PHY XS Control 1 Register (Register 4.0)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Reset	Logically ORed with the inverse of RSTN terminal. 1 = Global resets including FIFO clear. 0 = Normal operation (default)	Read/Write Self Clearing [†]
14	Loopback	1 = Enable loopback mode on all channels. 0 = Disable loopback mode on all channels (default).	Read/Write
13	Speed selection (LSB)	Not applicable. Read returns 1.	Read-only
12:7	Reserved	Not applicable. Read returns all 0s.	Read-only
6	Speed selection (MSB)	Not applicable. Read returns 1.	Read-only
5:2	Speed selection	Not applicable. Read returns all 0s.	Read-only
1:0	Reserved	Not applicable. Read returns all 0s.	Read-only

[†] After reset, this bit is set to 1; it automatically sets itself back to 0 on the next MDC clock cycle.

Table 3-32. PHY XS Status 1 Register (Register 4.1)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:8	Reserved	Read is ignored.	Read-only
7	Local fault	Logical OR of register 4.8, bits 10 and 11.	Read-only
6:3	Reserved	Read is ignored.	Read-only
2	TX link status	1 = Link is up 0 = Link is down Latches low until read.	Read-only
1:0	Reserved	Read is ignored.	Read-only

Table 3-33. PHY XS Speed Ability Register (Register 4.4)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:1	Reserved	Read returns all 0s.	Read-only
0	10G capable	Read returns 1.	Read-only

Table 3-34. Devices in Package Register (Register 4.5)

BIT(S)	NAME	DESCRIPTION	READ/WRITE	
15:6	Reserved	Read is ignored.	Read-only	
5	DTE XS present	1 = Device is configured as a DTE XS. 0 = Device is configured as a PHY XS.	Read-only	
4	PHY XS present	1 = Device is configured as a PHY XS. 0 = Device is configured as a DTE XS.	Read-only	
3:1	Not applicable	Read returns all 0s.	Read-only	
0	Clause 22 registers present	Read returns 1.	Read-only	

Table 3-35. 10G PHY XS Status 2 Register (Register 4.8)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Device present	Read returns 1.	Read-only
14	Device present	Read returns 0.	Read-only
13:12	Reserved	Read is ignored.	Read-only
11	Transmit local fault	1 = Transmit fault detected 0 = No transmit fault detected	Read-only
		Latches high until read.	
10	Receive local fault	1 = Receive fault detected0 = No receive fault detected	Read-only
		Latches high until read.	
9:0	Reserved	Read is ignored.	Read-only

Table 3–36. 10G PHY XGXS Lane Status Register (Register 4.24)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:13	Reserved	Read is ignored.	Read-only
12	Lane alignment	1 = PHY XGXS transmit lanes aligned 0 = PHY XGXS transmit lanes not aligned	Read-only
11:4	Reserved	Read is ignored.	Read-only
3	Lane D sync	Lane D is synchronized.	Read-only
2	Lane C sync	Lane C is synchronized.	Read-only
1	Lane B sync	Lane B is synchronized.	Read-only
0	Lane A sync	Lane A is synchronized.	Read-only

MDIO registers 4.32768-4.32781 are analogous to registers 16-29. The following table cross references the appropriate register definition.

Table 3-37. PHY XS Register Cross Reference (Registers 4.32768-4.32776)

REGISTER ADDRESS	NAME	EQUIVALENT REGISTER ADDRESS	EQUIVALENT REGISTER NAME	DEFINITION
4.32768	PHY XS global configuration	16	Global Configuration	See Table 3–18
4.32769-4.32772	PHY XS channels A–D configuration	17–20	Channels A–D Configuration	See Table 3–19, Table 3–20, Table 3–21, and Table 3–22
4.32774	PHY XS channel status	22	Channel Status	See Table 3–23
4.32775	PHY XS channel sync status	23	Channel Sync Status	See Table 3–24
4.32776	PHY XS CTC status	24	CTC Status	See Table 3–25
4.32777	Error counter control	25	Error Counter Control	See Table 3–26
4.32778-4.32781	Channels A–D error count	26–29	Channels A-D Error Count	See Table 3–27, Table 3–28, Table 3–29, and Table 3–30

Table 3-38. DTE XS Control 1 Register (Register 5.0)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15	Reset	Logically ORed with the inverse of RSTN terminal. 1 = Global resets including FIFO clear. 0 = Normal operation (default).	Read/Write Self Clearing [†]
14	Loopback	1 = Enable loopback mode on all channels. 0 = Disable loopback mode on all channels (default).	Read/Write
13	Speed selection (LSB)	Not applicable. Read returns 1.	Read-only
12:7	Reserved	Not applicable. Read returns all 0s.	Read-only
6	Speed selection (MSB)	Not applicable. Read returns 1.	Read-only
5:2	Speed selection	Not applicable. Read returns all 0s.	Read-only
1:0	Reserved	Not applicable. Read returns all 0s.	Read-only

[†] After reset, this bit is set to 1; it automatically sets itself back to 0 on the next MDC clock cycle.

Table 3-39. DTE XS Status 1 Register (Register 5.1)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:8	Reserved	Read is ignored.	Read-only
7	Local fault	Logical OR of register 5.8, bits 10 and 11.	Read-only
6:3	Reserved	Read is ignored.	Read-only
2	RX link status	1 = Link is up 0 = Link is down Latches low until read.	Read-only
1:0	Reserved	Read is ignored.	Read-only

Table 3-40. DTE XS Speed Ability Register (Register 5.4)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:1	Reserved	Read returns all 0s.	Read-only
0	10G capable	Read returns a 1.	Read-only

Table 3-41. Devices in Package Register (Register 5.5)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:6	Reserved	Read is ignored.	Read-only
5	DTE XS present	1 = Device is configured as a DTE XS. 0 = Device is configured as a PHY XS.	Read-only
4	PHY XS present	1 = Device is configured as a PHY XS. 0 = Device is configured as a DTE XS.	Read-only
3:1	Not applicable	Read returns all 0s.	Read-only
0	Clause 22 registers present	Read returns 1.	Read-only

Table 3-42. 10G DTE XS Status 2 Register (Register 5.8)

BIT(S)	(S) NAME DESCRIPTION		READ/WRITE	
15	Device present	Read returns 1.	Read-only	
14	Device present	Read returns 0.	Read-only	
13:12	Reserved	Read is ignored.	Read-only	
11	Transmit local fault	1 = Transmit fault detected 0 = No transmit fault detected	Read-only	
		Latches high until read.		
10	Receive local fault	1 = Receive fault detected 0 = No receive fault detected	Read-only	
		Latches high until read.		
9:0	Reserved	Read is ignored.	Read-only	

Table 3-43. 10G DTE XGXS Lane Status Register (Register 5.24)

BIT(S)	NAME	DESCRIPTION	READ/WRITE
15:13	Reserved	Read is ignored.	Read-only
12	Lane alignment	1 = DTE XGXS transmit lanes aligned 0 = DTE XGXS transmit lanes not aligned	Read-only
11:4	Reserved	Read is ignored.	Read-only
3	Lane D sync	Lane D is synchronized	Read-only
2	Lane C sync	Lane C is synchronized	Read-only
1	Lane B sync	Lane B is synchronized	Read-only
0	Lane A sync	Lane A is synchronized	Read-only

MDIO registers 5.32768–5.32781 are analogous to registers 16–29. The following table cross references the appropriate register definition.

Table 3-44. DTE XS Register Cross Reference (Registers 5.32768-5.32776)

REGISTER ADDRESS	NAME	EQUIVALENT REGISTER ADDRESS	EQUIVALENT REGISTER NAME	DEFINITION
5.32768	DTE XS global configuration	16	Global configuration	See Table 3–18
5.32769-5.32772	DTE XS channel A–D configuration	17–20	Channel A–D configuration	See Table 3–19, Table 3–20, Table 3–21, and Table 3–22
5.32774	DTE XS channel status	22	Channel status	See Table 3–23
5.32775	DTE XS channel sync status	23	Channel sync status	See Table 3–24
5.32776	DTE XS CTC status	24	CTC status	See Table 3–25
5.32777	Error counter control	25	Error counter control	See Table 3–26
5.32778-5.32781	Channel A-D error count	26–29	Channel A-D error count	See Table 3–27, Table 3–28, Table 3–29, and Table 3–30

3.26 Operating Frequency Range

The TLK3114SB device is optimized for operation at a serial data rate of 3.125 Gbps. The TLK3114SB device may operate at a serial data rate between 2.5 Gbps to 3.125 Gbps. The external differential reference clock has an operating frequency from 125 MHz to 156.25 MHz. The reference clock frequency must be within ± 100 PPM and have less than 40 ps of jitter.

3.27 Power-Down Mode

When the ENABLE terminal is held low, the TLK3114SB device enters a low power quiescent state. In this state, all analog and digital circuitry is disabled. In the power-down mode, the serial transmit and the receive data bus terminals for all channels are in a high-impedance state.

3.28 Loopback Testing

The TLK3114SB device can provide a self-test function by enabling the internal loop-back path with the assertion of LPENx for each channel, setting bit 14 (Loopback) of register 4.0 or 5.0, or by setting bit 3 (Loopback) of MDIO channel configuration registers 17–20, 4.32769–4.32772, or 5.32769–5.32772. Enabling this terminal or bit causes serial transmitted data to be routed internally to the receiver for that channel (see Figure 1–5). The parallel data output can be compared to the parallel input data for that channel to provide functional verification. The external differential output is held in a high-impedance state during the loop-back testing.

3.29 Power-On Reset

Upon application of minimum valid power, the TLK3114SB device generates an internal power-on reset. During the power-on reset the receive data terminals RDx[0:9] are tri-stated and the recovered receive clock terminals RC[A–D] are held low. The length of the power-on reset cycle is dependent upon the frequency of the reference clock, RFCP/RFCN, but is less than 1 ms in duration.

3.30 Differences From the TLK3104SA Device

The TLK3114SB device contains several functional improvements and extensions beyond those included in the TLK3104SA device. These differences are outlined in Table 3–45.

PARAMETER/FUNCTION **TLK3104SA TLK3114SB** Buffers optimized for 1.5-V HSTL, although they **HSTL** Supports HSTL scaled to 1.8 V still support 1.8-V scaled HSTL. See Section 3.10. Comma detect on both positive and negative Comma detect Comma detect on positive comma only commas. See Section 3.12. Improved error reporting LOS and decode errors reported as 0xFF Enhanced reporting. See Table 3-6. End-of-packet error detection and reporting Not supported Supported. See Section 3.14. Supported. See Section 3.15. Local fault and remote fault detection and Not supported reporting IPG code generation and stripping Not supported Supported. See Section 3.18. Clock tolerance compensation Not supported Supported. See Section 3.19. Repeater mode Not supported Supported. See Section 3.23. Power Low power Further reduced power Serial receive XAUI compliant Improved signal tolerance Terminal A1 **TRSTN ENABLE** Terminal U1 **ENABLE** DADR0 Clause 45 MDIO Not supported Supported. See Section 3.25. MDIO PHY/PRT address name DVAD[0:4] PADR[0:4] MDIO DEV address specifier Not supported DADR0. See Section 3.25.

Table 3-45. Comparison of TLK3104SA and TLK3114SB Devices

The ENABLE terminal on the TLK3104SA device is U1. On the TLK3114SB device the ENABLE terminal is terminal A1. The TLK3114SB device is compatible with a design intended for the TLK3104SA device. The TLK3104SA design would be required to pull U1 high and A1 high. If a TLK3114SB device was substituted then U1 would be ignored, since only clause 22 MDIO transactions would be executed, and A1 would still be required to be high. Also, the JTAG standard, IEEE 1149.1, specifies that TRSTN is optional as long as there is an ENABLE or reset terminal which accomplishes the same task. The TLK3114SB device places ENABLE where the TLK3104SA device had TRSTN so that JTAG function is unaffected.

MDIO register addresses have been renamed to better reflect terminology in IEEE 802.3ae clause 45. The name changes do not reflect a functional change.

4 Electrical Specifications

4.1 Absolute Maximum Ratings Over Operating Free-Air Temperature Range (unless otherwise noted)[†]

Supply voltage, V _{DD} , V _{DDQ} , V _{DDA}	0.3 to 3 V
Input voltage, VI, (LVTTL)	
Input voltage, VI, (HSTL/SSTL_2 Class 1)	0.5 to 4 V
DC input voltage (I/O)	0.3 to 3 V
Storage temperature	–65°C to 150°C
Electrostatic discharge	HBM: 2 kV, CDM: 750 V
Characterized free-air operating temperature range	0°C to 70°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE: All voltage values, except differential I/O bus voltages, are stated with respect to the network ground terminal.

4.2 Recommended Operating Conditions

			MIN	NOM	MAX	UNIT
Core supply voltage, V _{DD}			2.3	2.5	2.7	V
10 1 1 1	SSTL_2 Class 1		2.3	2.5	2.7	V
I/O supply voltage, V _{DDQ}	HSTL Class 1		1.4	1.5	1.9	V
Analog supply voltage, V _{DDA}			2.3	2.5	2.7	V
Core supply current, I _{DD}	$R_{\odot} = 156.25 \text{ MHz}$			500	650	mA
1/0	SSTL_2 Class 1,	$R_{\omega} = 156.25 \text{ MHz}$		150	325	mA
I/O supply current, I _{DDQ}	HSTL Class 1	R_{ω} = 156.25 MHz		120	200	mA
Analog supply current, IDDA	$R_{\odot} = 156.25 \text{ MHz}$			280	320	mA
	Transceiver mode,	R_{ω} = 156.25 MHz		2.25	3.25	W
Total names against D	Transmit mode,	R_{ω} = 156.25 MHz		0.9	1.5	W
Total power consumption, P _D	Receive mode,	R_{ω} = 156.25 MHz		2	2.8	W
	Repeater mode,	R_{ω} = 156.25 MHz		1.8	2.2	W
least reference with a V	SSTL_2 Class 1		1.15	1.25	1.35	V
Input reference voltage, V _{REF†}	HSTL Class 1		0.68	0.75	0.9	V
Analog shutdown current, ISDA	ENABLE = Low			300		μΑ
Core shutdown current, I _{SDD}	ENABLE = Low			500		μΑ

The value of VREF may be selected to provide optimum noise margin in the system. Typically, the value of VREF is expected to be $0.5V_{DDQ}$ of the transmitting device and V_{REF} is expected to track variations in V_{DDQ} . Peak-to-peak ac noise on V_{REF} may not exceed $\pm 2\%$ of V_{REF} (dc).

4.3 Reference Clock Timing Requirements (RFCP/N)

These characteristics are over recommended operating conditions unless otherwise noted.

PARAMETER		TEST CONDITION	MIN	TYP	MAX	UNIT
	_	Minimum data rate	TYP-0.01%	125	TYP+0.01%	N 41 1-
R_{ω}	Frequency	Maximum data rate	TYP-0.01%	156.25	TYP+0.01%	MHz
	Accuracy		-100		100	ppm
	Duty cycle		40%	50%	60%	
	Jitter	Random and deterministic		·	40	ps

This clock must be crystal referenced to meet the requirements of the above table. Contact TI for specific clocking recommendations.

4.4 Reference Clock Electrical Characteristics (RFCP/N)

These characteristics are over recommended operating conditions unless otherwise noted.

	PARAMETER	MIN	TYP	MAX	UNIT
٧ _I	Input voltage	825		1675	mV
Vidth	Differential input voltage	200			mVp-P
C _{IN}	Input capacitance			3	pF
R _{IN}	Input differential impedance	80	100	120	Ω

4.5 LVTTL Electrical Characteristics

These characteristics are over recommended operating conditions unless otherwise noted.

See Chapter 2, Terminal Descriptions, for a list of LVTTL signals.

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
Vон	High-level output voltage	$I_{OH} = -400 \mu\text{A}, V_{DD} = MIN$	V _{DD} -0.2		V_{DD}	V
VOL	Low-level output voltage	$I_{OL} = 4 \text{ mA}, \qquad V_{DD} = \text{MIN}$	0	0.25	0.6	V
VIH	High-level input voltage		2		3.5	V
VIL	Low-level input voltage				0.8	V
lΗ	High input current	$V_{DD} = MAX$, $V_{IN} = 2 V$			40	μΑ
IL	Low input current	$V_{DD} = MAX$, $V_{IN} = 0.4 V$			-600	μΑ
C _{IN}	Input capacitance				4	pF

4.6 SSTL_2 Class 1 Signals

See Chapter 2, Terminal Descriptions, for a list of SSTL_2 Class 1 signals.

NOTE:

For more information on SSTL_2 Class 1 specifications and test conditions, see EIA/JEDEC, Stub Series Terminated Logic For 2.5 V (SSTL_2), EIA/JESD8-9A, Dec 2000.

	PARAMETER	TEST CONDITION	MIN	TYP MAX	UNIT
V _{OH(dc)}	High-level output voltage		1.76		V
V _{OL(dc)}	Low-level output voltage			0.74	V
VIH(dc)	High-level dc input voltage	DC input, logic high	V _{ref} +0.18	V _{DDQ} +0.3	V
V _{IL(dc)}	Low-level dc input voltage	DC input, logic low	-0.3	V _{ref} -0.18	V
V _{IH(ac)}	High-level ac input voltage	AC input, logic high	V _{ref} +0.35		V
V _{IL} (ac)	Low-level ac input voltage	AC input, logic low		V _{ref} -0.35	V
IOH(dc)	High output current	$V_{DDQ} = 2.3 \text{ V},$ $V_{OUT} = V_{DDQ} - 0.62 \text{ V}$	-7.6		mA
I _{OL(dc)}	Low output current	V _{DDQ} = 2.3 V, V _{OUT} = 0.54 V	7.6	·	mA
C _{IN}	Input capacitance			4	pF

4.7 HSTL Signals

See Chapter 2, Terminal Descriptions, for a list of HSTL signals.

NOTE:

For more information on HSTL specifications and test conditions, see EIA/JEDEC, High-Speed Transceiver Logic (HSTL): A 1.5-V Output Buffer Supply Voltage Based Interface Standard for Digital Integrated Circuits, EIA/JESD8-6, Aug 1995.

	PARAMETER	CONDITION	MIN	TYP MAX	UNIT
VOH(dc)	High-level output voltage		V _{DDQ} -0.4	V_{DDQ}	V
V _{OL(dc)}	Low-level output voltage			0.4	V
VIH(dc)	High-level dc input voltage	DC input, logic high	V _{ref} +0.1	V _{DDQ} +0.3	V
V _{IL(dc)}	Low-level dc input voltage	DC input, logic low	-0.3	V _{ref} -0.1	V
VIH(ac)	High-level ac input voltage	AC input, logic high	V _{ref} +0.2		V
V _{IL(ac)}	Low-level ac input voltage	AC input, logic low		V _{ref} -0.2	V
IOH(dc)	High output current	V _{DDQ} = 1.5 V	-8		mA
I _{OL(dc)}	Low output current	V _{DDQ} = 1.5 V	8		mA
C _{IN}	Input capacitance			4	pF

4.8 Serial Transmitter/Receiver Characteristics

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
V _{OD(p)}	TX output voltage magnitude away from common	Maximum preemphasis enabled, See Figure 4–1	650	850	1000	mV
VOD(d)	mode	Preemphasis disabled, See Figure 4–1	600		800	mV
VOD(pp)		Maximum preemphasis enabled, See Figure 4–1	1300	1700	2000	m∨p-p
V _{OD(pd)}	TX output differential peak-to-peak voltage swing	Preemphasis disabled, See Figure 4–1	1200	1450	1600	m∨p-p
VCMT	TX output common mode voltage range	See Figure 4–1	1000	1250	1400	mV
V _{ID}	RX input voltage magnitude away from common mode	See Figure 4–3	100		1150	mV
V _{ID(p)}	RX input differential peak-to-peak voltage swing	See Figure 4–3	200		2300	m∨p-p
V _{CMR}	RX input common mode voltage range	See Figure 4–3	1000		2000	mV
I _{LKG}	RX input leakage current		-10		10	μΑ
Cl	RX input capacitance				2	pF
t _r , t _f	Differential output signal rise, fall time (20% to 80%)	$R_L = 50 \Omega$, $C_L = 5 pF$, See Figure 4–1	80	90	130	ps
JTOL	Jitter tolerance, total jitter at serial input	Zero crossing, See Figure 4–4			0.65	UI†
JDR	Serial input deterministic jitter	Zero crossing, See Figure 4–4			0.37	UI
JS	Serial input sinusoidal jitter <20 MHz				0.1	UI
JT	Serial output total jitter	PRBS at 3.125 GHz, See Figure 4–2		0.2	0.35	UI
J _D	Serial output deterministic jitter	PRBS at 3.125 GHz			0.17	UI
R(LATENCY)	Total delay from RX input to RD output	See Figure 3–6	89		225	Bits
T _(LATENCY)	Total delay from TD input to TX output	See Figure 3–2	71		120	Bits

[†] Unit interval (UI) is one serial bit time (320 ps minimum).

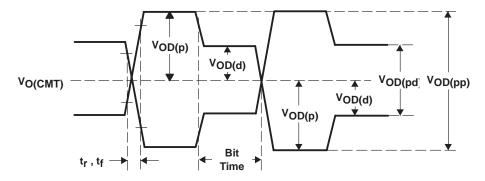


Figure 4-1. Differential and Common-Mode Output Voltage Definitions

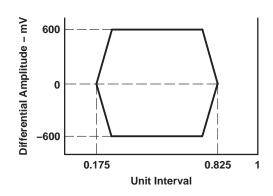
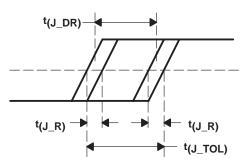


Figure 4-2. Transmit Template

Figure 4-3. Receive Template



NOTE: $t(J_TOL) = t(J_R) + t(J_DR)$, where $t(J_TOL)$ is the receive jitter tolerance, $t(J_DR)$ is the received deterministic jitter, and $t(J_R)$ is the Gaussian random edge jitter distribution at a maximum BER = 10^{-12} .

Figure 4-4. Input Jitter

4.9 SSTL_2 Class 1/HSTL Output Switching Characteristics

These characteristics are over recommended operating conditions unless otherwise noted.

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
t _{su}	RDx[0:9] setup prior to RCx transition high or low	See Figure 4–5, timing relative to 0.5xV _{DDQ}	960			ps
th	RDx[0:9] hold after RCx transition high or low	See Figure 4–5, timing relative to 0.5xV _{DDQ}	960			ps
slew	RDx[0:9] slew rate	C _L = 10 pF	1		·	mV/ps

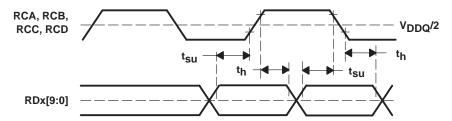


Figure 4-5. SSTL_2 Class 1/HSTL Output Timing Requirements

4.10 SSTL_2 Class 1/HSTL Input Timing Requirements

These characteristics are over recommended operating conditions unless otherwise noted.

	PARAMETER	TEST CONDITION	MIN [†]	TYP	MAX	UNIT
t _{su}	TDx[0:9] setup prior to TCx transition high or low	See Figure 4–6, timing relative to V _{REF}	480			ps
th	TDx[0:9] hold after TCx transition high or low	See Figure 4-6, timing relative to VREF	480			ps

[†] All values are at 25°C with a nominal supply.

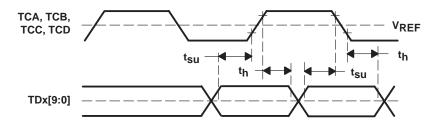


Figure 4-6. SSTL_2 Class 1/HSTL Data Input Timing Requirements

4.11 MDIO Timing Requirements

These characteristics are over recommended operating conditions unless otherwise noted.

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
tperiod	MDC period	See Figure 4–7	50	400		ns
t _{su}	MDIO setup to ↑ MDC	See Figure 4–7	10			ns
th	MDIO hold to ↑ MDC	See Figure 4–7	10			ns

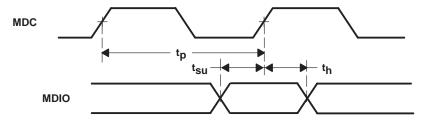


Figure 4-7. MDIO Read/Write Timing

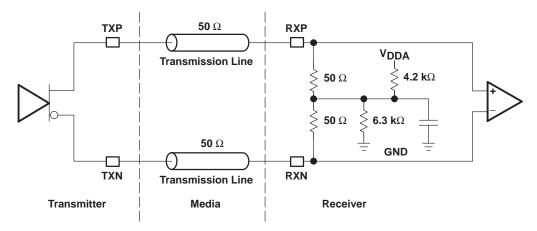


Figure 4–8. High-Speed I/O Direct-Coupled Mode

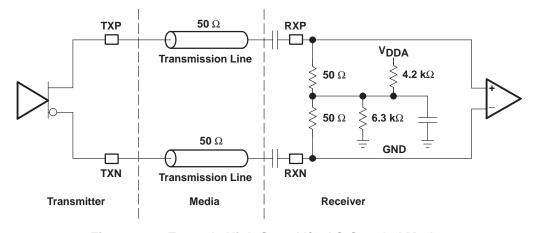
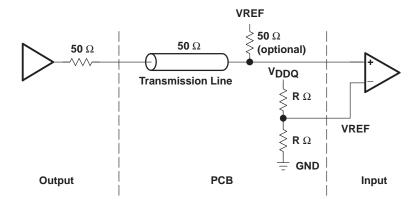
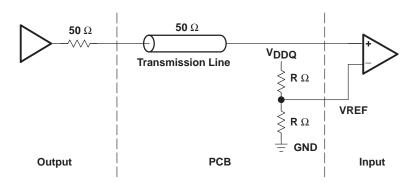


Figure 4–9. Example High-Speed I/O AC-Coupled Mode



NOTE: The output buffer of the TLK3114SB has on-chip termination of 50 Ω . The output signal is compliant with the JEDEC SSTL_2 Class 1 specification. Line termination on the receive end is optional and not recommended for low-power applications.

Figure 4-10. SSTL_2 Class 1 I/O



NOTE: The TLK3114SB provides a push-pull effect on the output buffer for externally sourced series terminated loads. In HSTL mode, the signal swing is small, allowing for minimal power consumption and low electromagnetic emission (EME). To assure sufficient signal levels on the receive side, no termination resistor is used.

Figure 4-11. HSTL I/O

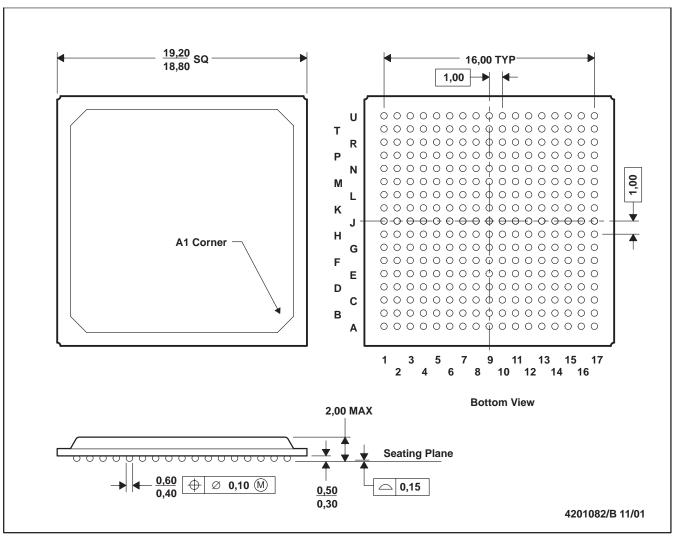
4.12 Package Dissipation Rating

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
		Airflow = 0 M/S		21.6		°C/W
θ_{JA}	Junction to free air thermal resistance	Airflow = 1 M/S		17.8		°C/W
		Airflow = 2 M/S		16.7		°C/W

5 Mechanical Data

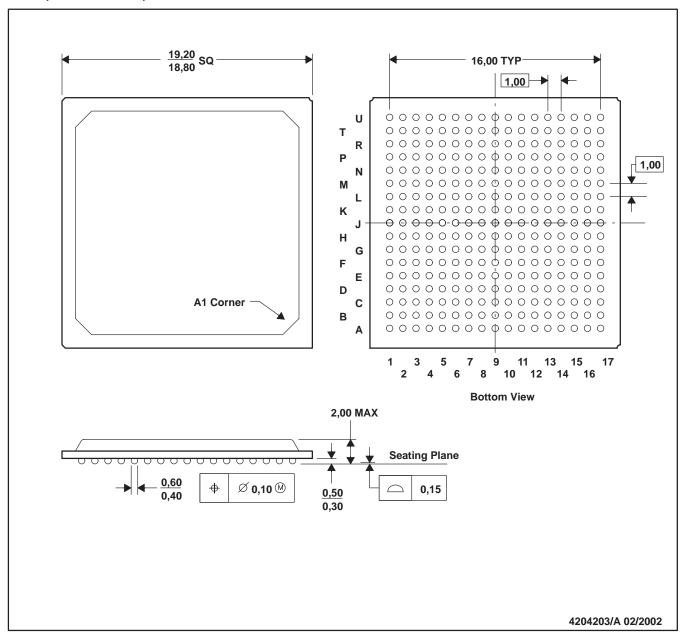
GNT (S-PBGA-N289)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.





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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pacl Q	_	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLK3114SBGNT	NRND	BGA	GNT	289 8	4	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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